SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

DESCRIPTION

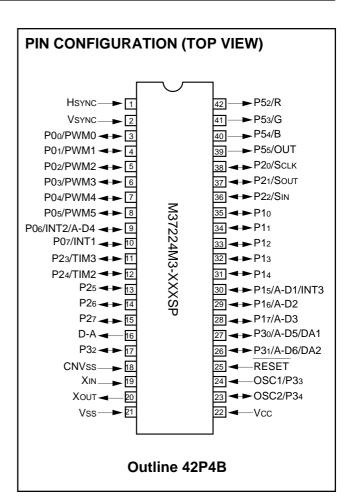
The M37224M3-XXXSP is a single-chip microcomputer designed with CMOS silicon gate technology. They are housed in a 42-pin shrink plastic molded DIP.

In addition to their simple instruction sets, the ROM, RAM and I/O addresses are placed on the same memory map to enable easy programming.

The M37224M3-XXXSP has a PWM output function and a OSD display function, so it is useful for a channel selection system for TV.

FEATURES

Number of basic instructions	
 Memory size 	
ROM	12 K bytes
RAM	256 bytes
ROM for display	8 K bytes
RAM for display	
 Minimum instruction execution time 	
0.5 μs (at 8	MHz oscillation frequency)
Power source voltage	5 V ± 10 %
Power dissipation	165 mW
(at 8 MHz oscillation frequency, Vcc=	=5.5V, at CRT display)
Subroutine nesting	96 levels (maximum)
Interrupts	13 types, 13 vectors
Interrupts8-bit timers	31
•	
• 8-bit timers	
 8-bit timers Programmable I/O ports (Ports P0, P1, Input ports (Ports P33, P34) 	
 8-bit timers Programmable I/O ports (Ports P0, P1, 	4 P2, P30–P32)
 8-bit timers Programmable I/O ports (Ports P0, P1, Input ports (Ports P33, P34) Output ports (Ports P52–P55) 	4 P2, P30–P32)
 8-bit timers Programmable I/O ports (Ports P0, P1, Input ports (Ports P33, P34) Output ports (Ports P52–P55) 12 V withstand ports 	4 P2, P30–P32)
 8-bit timers Programmable I/O ports (Ports P0, P1, Input ports (Ports P33, P34) Output ports (Ports P52–P55) 12 V withstand ports LED drive ports 	4 P2, P30–P32)
 8-bit timers Programmable I/O ports (Ports P0, P1, Input ports (Ports P33, P34) Output ports (Ports P52–P55) 12 V withstand ports LED drive ports Serial I/O 	4 P2, P30–P32)
 8-bit timers Programmable I/O ports (Ports P0, P1, Input ports (Ports P33, P34) Output ports (Ports P52–P55) 12 V withstand ports LED drive ports Serial I/O A-D comparator (6-bit resolution) 	4 P2, P30–P32)
 8-bit timers Programmable I/O ports (Ports P0, P1, Input ports (Ports P33, P34) Output ports (Ports P52–P55) 12 V withstand ports LED drive ports Serial I/O A-D comparator (6-bit resolution) D-A converter (6-bit resolution) 	4 P2, P30–P32)



CRT display function

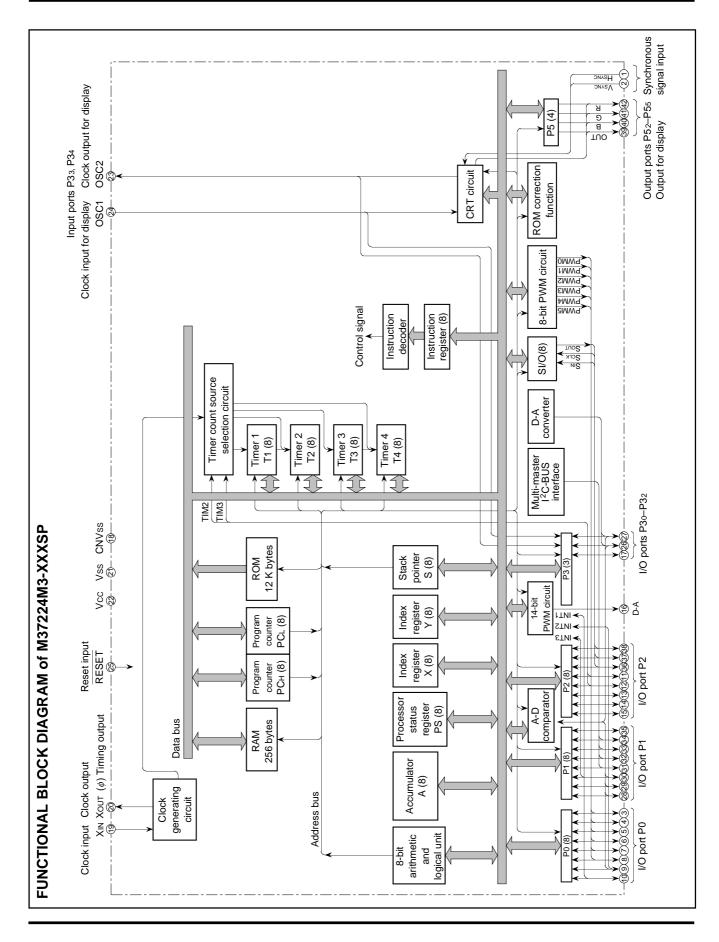
Number of display characters 20 characters X 2 lines
(16 lines maximum)
Kinds of characters 128 kinds
Dot structure 12 X 16 dots
Kinds of character sizes 3 kinds
Kinds of character colors (It can be specified by the character) maximum 7 kinds (R, G, B)
Kinds of raster colors (maximum 7 kinds)
Display position
Horizontal 64 levels
Vertical 128 levels

Bordering (horizontal and vertical)

APPLICATION

TV







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FUNCTIONS

	Parameter		Functions					
Number of basic instruction	ns		71					
Instruction execution time			0.5 $\mu \rm s$ (the minimum instruction execution time, at 8 MHz oscillation frequency)					
Clock frequency			8 MHz (maximum)					
Memory size	ROM		12 K bytes					
	RAM		256 bytes					
	CRT ROM		4 K bytes					
	CRT RAM		80 bytes					
Input/Output ports	P0	I/O	8-bit X 1 (N-channel open-drain output structure, can be used as PWM output pins, INT input pins, A-D input pin)					
	P10-P17	I/O	8-bit X 1 (CMOS input/output structure, can be used as A-D input pins, INT input pin)					
	P20, P21	I/O	2-bit X 1 (CMOS input/output or N-channel open-drain output structure, can be used as serial I/O pins)					
	P22-P27	I/O	6-bit X 1 (CMOS input/output structure, can be used as serial input pin, external clock input pins)					
	P30, P31	I/O	2-bit X 1 (CMOS input/output or N-channel open-drain output structure, can be used as A-D input pins, D-A conversion output pins)					
	P32	I/O	1-bit X 1 (N-channel open-drain output structure)					
	P33, P34	Input	2-bit X 1 (can be used as CRT display clock I/O pins)					
	P52-P55	Output	4-bit X 1 (CMOS output structure, can be used as CRT output pins)					
Serial I/O			8-bit X 1					
A-D comparator			6 channels (6-bit resolution)					
D-A converter			2 (7-bit resolution)					
PWM output circuit			14-bit X 1, 8-bit X 6					
Timers			8-bit timer X 4					
ROM correction function			32 bytes X 2					
Subroutine nesting			96 levels (maximum)					
Interrupt			External interrupt X 3, Internal timer interrupt X 4, Serial I/O interrupt X CRT interrupt X 1, f(XIN)/4096 interrupt X 1, VSYNC interrupt X BRK interrupt X 1					
Clock generating circuit			2 built-in circuits (externally connected to a ceramic resonator or a quart crystal oscillator)					
Power source voltage			5 V ± 10 %					
Power dissipation	CRT ON		165 mW typ. (at oscillation frequency f(XIN) = 8 MHz, fCRT = 8 MHz)					
	CRT OFF		110 mW typ. (at oscillation frequency $f(XIN) = 8 \text{ MHz}$)					
	In stop mode		1.65 mW (maximum)					
Operating temperature ran	ge		–10 °C to 70 °C					
Device structure			CMOS silicon gate process					
Package			42-pin shrink plastic molded DIP					
CRT display function	Number of disp	olay characters	20 characters X 2 lines (maximum 16 lines by software)					
	Dot structure		12 X 16 dots					
	Kinds of chara	cters	128 kinds					
	Kinds of chara	cter sizes	3 kinds					
	Kinds of chara	cter colors	Maximum 7 kinds (R, G, B); can be specified by the character					
	Display position (h	orizontal, vertical)	64 levels (horizontal) X 128 levels (vertical)					



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PIN DESCRIPTION

Pin	Name	Input/ Output	Functions
Vcc, Vss.	Power source		Apply voltage of 5 V \pm 10 % (typical) to Vcc, and 0 V to Vss.
CNVss	CNVss		Connected to Vss.
RESET	Reset input	Input	To enter the reset state, the reset input pin must be kept at a "L" for 2 μ s or more (under normal Vcc conditions). If more time is needed for the quartz-crystal oscillator to stabilize, this "L" condition should be maintained for the required time.
Xin	Clock input	Input	This chip has an internal clock generating circuit. To control generating frequency, an external ceramic resonator or a quartz-crystal oscillator is connected between pins XIN and
Xout	Clock output	Output	XOUT. If an external clock is used, the clock source should be connected to the XIN pin and the XOUT pin should be left open.
P00/PWM0– P05/PWM5, P06/INT2/	I/O port P0	I/O	Port P0 is an 8-bit I/O port with direction register allowing each I/O bit to be individually programmed as input or output. At reset, this port is set to input mode. The output structure is N-channel open-drain output. See notes at end of Table for full details of port P0 functions.
A-D4, P07/INT1	PWM output	Output	Pins P00–P05 are also used as PWM output pins PWM0–PWM5 respectively. The output structure is N-channel open-drain output.
	External interrupt input	Input	Pins P06, P07 are also used as external interrupt input pins INT2, INT1 respectively.
	Analog input	Input	P06 pin is also used as analog input pin A-D4.
P10–P14, P15/A-D1/	I/O port P1	I/O	Port P1 is an 8-bit I/O port and has basically the same functions as port P0. The output structure is CMOS output.
INT3,	Analog input	Input	Pins P15–P17 are also used as analog input pins A-D1 to A-D3 respectively.
P16/A-D2, P17/A-D3	External interrupt input	Input	P15 pin is also used as external interrupt input pin INT3.
P20/SCLK, P21/SOUT,	I/O port P2	I/O	Port P2 is an 8-bit I/O port and has basically the same functions as port P0. The output structure is CMOS output.
P22/SIN, P23/TIM3,	External clock input	Input	Pins P23, P24 are also used as external clock input pins TIM3, TIM2 respectively.
P24/TIM2, P25–P27	Serial I/O synchro- nous clock input/ output	I/O	P20 pin is also used as serial I/O synchronous clock input/output pin SCLK. The output structure is N-channel open-drain output.
	Serial I/O data output	Output	Pin P21 is also used as serial I/O data output pin SOUT. The output structure is N-channel open-drain output.
	Serial I/O data input	Input	Pin P22 is also used as serial I/O data input pin SIN.
P30/A-D5/ DA1, P31/A-D6/	I/O port P3	I/O	Ports P30–P32 are 3-bit I/O ports and have basically the same functions as port P0. Either CMOS output or N-channel open-drain output structure can be selected as the port P30 and P31. The output structure of port P32 is N-channel open-drain output.
DA2, P32	Analog input	Input	Pins P30, P31 are also used as analog input pins A-D5, A-D6 respectively.
. 52	D-A conversion output	Output	Pins P30, P31 are also used as D-A conversion output pins DA1, DA2 respectively.
P33/OSC1,	Input port P3	Input	Ports P33, P34 are 2-bit input ports.
P34/OSC2	Clock input for CRT display	Input	P33 pin is also used as CRT display clock input pin OSC1.
	Clock output for CRT display	Output	P34 pin is also used as CRT display clock output pin OSC2. The output structure is CMOS output.



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PIN DESCRIPTION (continued)

Pin	Name	Input/ Output	Functions
P52/R, P53/G,	Output port P5	Output	Ports P52–P55 are a 4-bit output port. The output structure is CMOS output.
P54/B, P55/OUT	CRT output	Output	Pins P52–P55 are also used as CRT output pins R, G, B, OUT respectively. The output structure is CMOS output.
Hsync	HSYNC input	Input	This is a horizontal synchronous signal input for CRT.
Vsync	VSYNC input	Input	This is a vertical synchronous signal input for CRT.
D-A	DA output	Output	This is a 14-bit PWM output pin.

Note : As shown in the memory map (Figure 5), port P0 is accessed as a memory at address $00C0_{16}$ of zero page. Port P0 has the port P0 direction register (address $00C1_{16}$ of zero page) which can be used to program each bit as an input ("0") or an output ("1"). The pins programmed as "1" in the direction register are output pins. When pins are programmed as "0," they are input pins. When pins are programmed as "0," they are input pins. When pins are programmed as "0," they are input pins, the output data are written into the port latch and then output. When data is read from the output pins, the output pin level is not read but the data of the port latch is read. This allows a previously-output value to be read correctly even if the output LOW voltage has risen, for example, because a light emitting diode was directly driven. The input pins are float, so the values of the pins can be read. When data is written into the input pin, it is written only into the port latch, while the pin remains in the floating state.



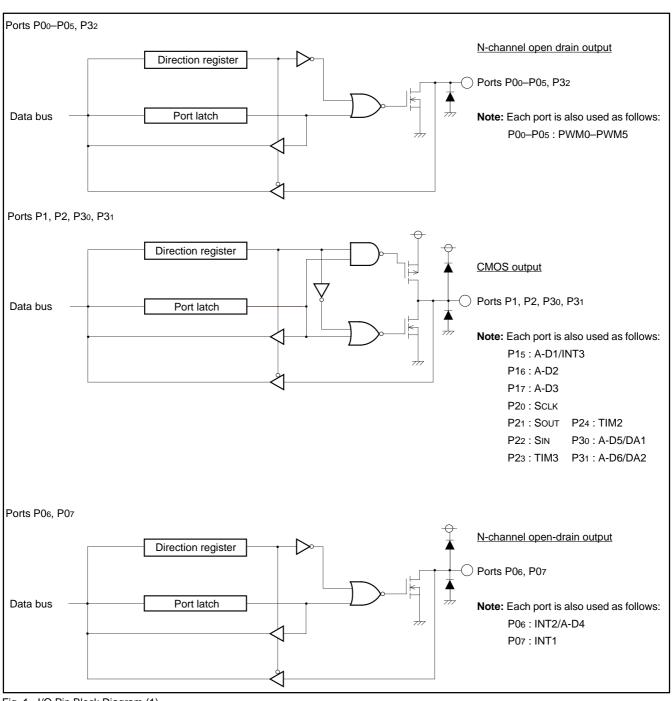


Fig. 1. I/O Pin Block Diagram (1)



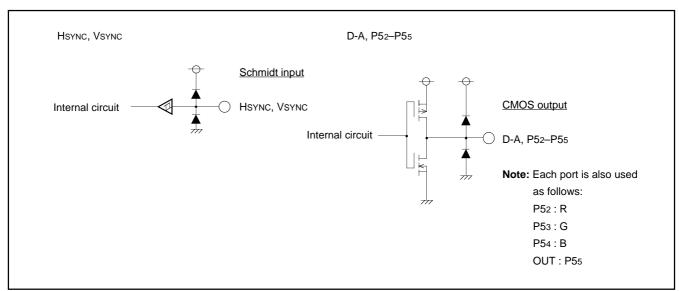


Fig. 2. I/O Pin Block Diagram (2)



FUNCTIONAL DESCRIPTION Central Processing Unit (CPU)

The M37224M3-XXXSP uses the standard 740 Family instruction set. Refer to the table of 740 Family addressing modes and machine instructions or the SERIES 740 <Software> User's Manual for details on the instruction set.

Machine-resident 740 family instructions are as follows:

The FST, SLW instruction cannot be used.

The MUL, DIV, WIT and STP instructions can be used.

CPU Mode Register

The CPU mode register contains the stack page selection bit. The CPU mode register is allocated at address 00FB16.

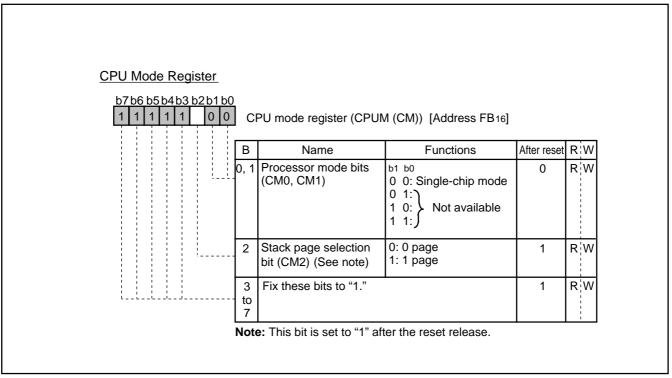


Fig. 3. CPU Mode Register



MEMORY Special Function Register (SFR) Area

The special function register (SFR) area in the zero page contains control registers such as I/O ports and timers.

RAM

RAM is used for data storage and for stack area of subroutine calls and interrupts.

ROM

ROM is used for storing user programs as well as the interrupt vector area.

RAM for Display

RAM for display is used for specifying the character codes and colors to display.

ROM for Display

ROM for display is used for storing character data.

Interrupt Vector Area

The interrupt vector area contains reset and interrupt vectors.

Zero Page

The 256 bytes from addresses 000016 to 00FF16 are called the zero page area. The internal RAM and the special function registers (SFR) are allocated to this area.

The zero page addressing mode can be used to specify memory and register addresses in the zero page area. Access to this area with only 2 bytes is possible in the zero page addressing mode.

Special Page

The 256 bytes from addresses FF0016 to FFFF16 are called the special page area. The special page addressing mode can be used to specify memory addresses in the special page area. Access to this area with only 2 bytes is possible in the special page addressing mode.

ROM Correction Memory (RAM)

This is used as the program area for ROM correction.

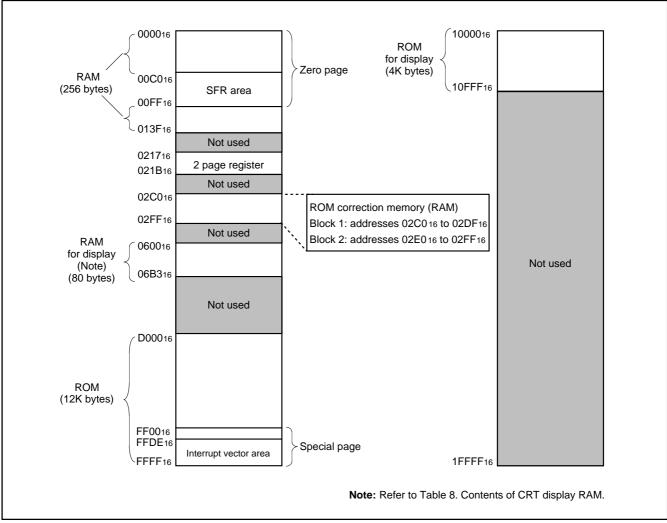


Fig. 4. Memory Map



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_0	ea (addresses C016	<bit allocation=""> <state after="" immediately="" reset=""></state></bit>	
		0 : "0" immediately after reset	
		Image: Second	
		No function bit Indefined immediately	
		0 : Fix this bit to "0"	
		(do not write "1")	
		1 : Fix this bit to "1" (do not write "0")	
Address	Register	Bit allocation State immediately after res	set
CO16 Port P	0 (P0)		
	0 direction register (D0)	0016	
C2 ₁₆ Port P		?	
	1 direction register (D1)	0016	
C416 Port P		?	
	2 direction register (D2)	0016	
C616 Port P			?
	3 direction register (D3)	0016	
C8 16		?	
C916 CA16 Port P	5 (D5)	?	
	5 direction register (D5)	0 0 ? ? ? ? ? 0016	?
CC16		?	
	output mode control register (P3S)	DA2S DA1S P31S P30S 0016	
	register (DA-H)	?	
	egister (DA-L)		?
	register (PWM0)		
0116 PWM1	register (PWM1)	?	
0216 PWM2	register (PWM2)	?	
0316 PWM3	register (PWM3)	?	
	register (PWM4)	?	
	output control register 1 (PW)	PW7 PW6 PW5 PW4 PW3 PW2 PW1 PW0 0016	
	output control register 2 (PN)	PN4 PN3 PN2 0016	
D7 16		?	
0816		?	
D9 16		?	
DA16		?	
)B16)C10 Serial	I/O mode register (SM)	?	
	I/O regsiter (SIO)	SM6 SM5 0 SM3 SM2 SM1 SM0 0016	
	onversion register (DA1)	2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	
	onversion register (DA2)	DA17 O DA15 DA14 DA13 DA12 DA11 DA10 ? DA27 O DA25 DA24 DA23 DA22 DA21 DA20 ?	

Fig. 5. Memory Map of SFR (special function register) (1)



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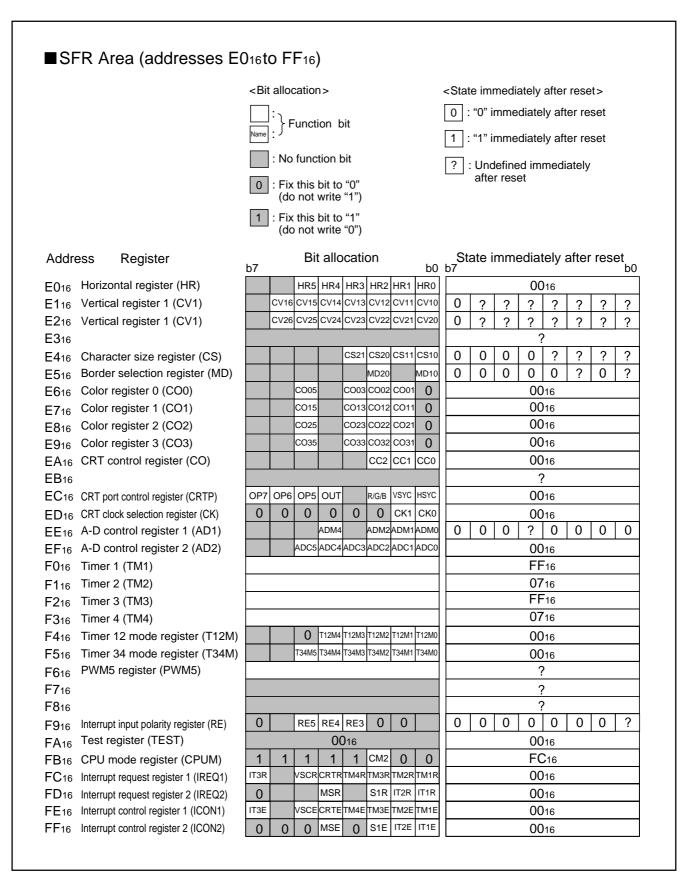


Fig. 6. Memory Map of SFR (special function register) (2)



■SFR Area (addresses 217	16 to 21B 16)	
	<bit allocation=""></bit>	<state after="" immediately="" reset=""></state>
	 Function bit No function bit : No function bit : Fix this bit to "0" (do not write "1") : Fix this bit to "1" (do not write "0") 	 0 : "0" immediately after reset 1 : "1" immediately after reset ? : Undefined immediately after reset
Address Register	b7 Bit allocation b0	State immediately after reset
21716 ROM correction address 1 (high-order)		0016
21816 ROM correction address 1 (low-order)		0016
21916 ROM correction address 2 (high-order)		0016
21A16 ROM correction address 2 (low-order)		0016
21B16 ROM correction enable register (RCR)	0 0 RC1 RC0	? ? ? ? 0 0 0 0

Fig. 7. Memory Map of 2 Page Register

	<bit allocation=""></bit>	<state after="" immediately="" reset=""> [0] : "0" immediately after reset</state>
	Name : J	: "1" immediately after reset : Undefined immediately after reset
	 i Fix this bit to "0" (do not write "1") i Fix this bit to "1" (do not write "0") 	
Register Processor status register (PS)		State immediately after reset
Program counter (PCH) Program counter (PCL)	N V T B D I Z C	C ? ? ? ? ? ? 1 ? ? Contents of address FFFF ₁₆ Contents of address FFFE ₁₆

Fig. 8. Internal State of Processor Status Register and Program Counter at Reset



INTERRUPTS

Interrupts can be caused by 13 different sources consisting of 4 external, 7 internal, 1 software, and reset. Interrupts are vectored interrupts with priorities shown in Table 1. Reset is also included in the table because its operation is similar to an interrupt.

When an interrupt is accepted,

- The contents of the program counter and processor status register are automatically stored into the stack.
- (2) The interrupt disable flag I is set to "1" and the corresponding interrupt request bit is set to "0."
- (3) The jump destination address stored in the vector address enters the program counter.

Other interrupts are disabled when the interrupt disable flag is set to "1."

All interrupts except the BRK instruction interrupt have an interrupt request bit and an interrupt enable bit. The interrupt request bits are in interrupt request registers 1 and 2 and the interrupt enable bits are in interrupt control registers 1 and 2. Figures 10 to 14 show the interrupt-related registers.

Interrupts other than the BRK instruction interrupt and reset are accepted when the interrupt enable bit is "1," interrupt request bit is "1," and the interrupt disable flag is "0." The interrupt request bit can be set to "0" by a program, but not set to "1." The interrupt enable bit can be set to "0" and "1" by a program.

Reset is treated as a non-maskable interrupt with the highest priority. Figure 9 shows interrupt control.

Interrupt Causes

is completed.

 VSYNC and CRT interrupts
 The VSYNC interrupt is an interrupt request synchronized with the vertical sync signal.
 The CRT interrupt occurs after character block display to the CRT

(2) INT1, INT2, INT3 interrupts

With an external interrupt input, the system detects that the level of a pin changes from "L" to "H" or from "H" to "L," and generates an interrupt request. The input active edge can be selected by bits 3, 4 and 5 of the interrupt input polarity register (address 00F916) : when this bit is "0," a change from "L" to "H" is detected; when it is "1," a change from "H" to "L" is detected. Note that all bits are cleared to "0" at reset.

(3) Timer 1, 2, 3 and 4 interrupts

An interrupt is generated by an overflow of timer 1, 2, 3 or 4. (4) Serial I/O interrupt

This is an interrupt request from the clock synchronous serial I/O function.

Interrupt Source	Priority	Vector Addresses	Remarks
Reset	1	FFFF16, FFFE16	Non-maskable
CRT interrupt	2	FFFD16, FFFC16	
INT2 interrupt	3	FFFB16, FFFA16	Active edge selectable
INT1 interrupt	4	FFF916, FFF816	Active edge selectable
Timer 4 interrupt	5	FFF516, FFF416	
f(XIN)/4096 interrupt	6	FFF316, FFF216	
VSYNC interrupt	7	FFF116, FFF016	Active edge selectable
Timer 3 interrupt	8	FFEF16, FFEE16	
Timer 2 interrupt	9	FFED16, FFEC16	
Timer 1 interrupt	10	FFEB16, FFEA16	
Serial I/O interrupt	11	FFE916, FFE816	
INT3 interrupt	12	FFE516, FFE416	Active edge selectable
BRK instruction interrupt	13	FFDF16, FFDE16	Non-maskable (software interrupt)

Table 1. Interrupt Vector Addresses and Priority



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(5) f(XIN)/4096 interrupt

This interrupt occurs regularly with a f(XIN)/4096 period. Set bit 0 of the PWM output control register 1 to "0."

(6) BRK instruction interrupt

This software interrupt has the least significant priority. It does not have a corresponding interrupt enable bit, and it is not affected by the interrupt disable flag I (non-maskable).

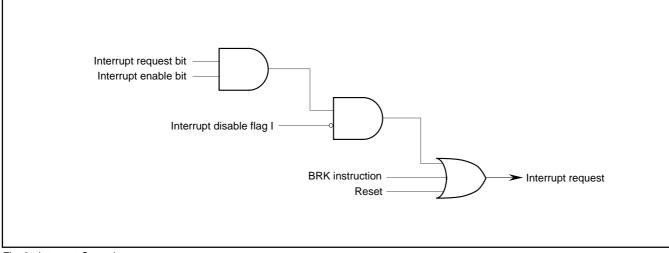


Fig. 9. Interrupt Control



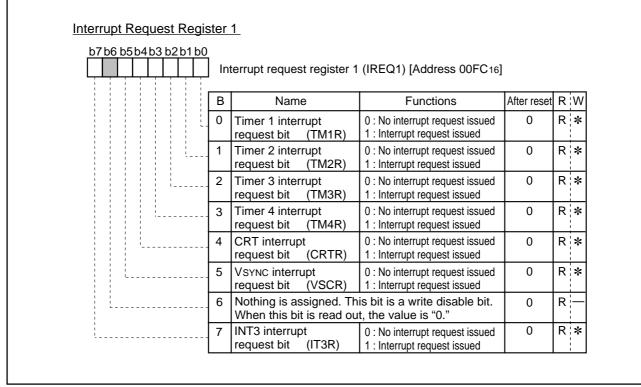


Fig. 10. Interrupt Request Register 1

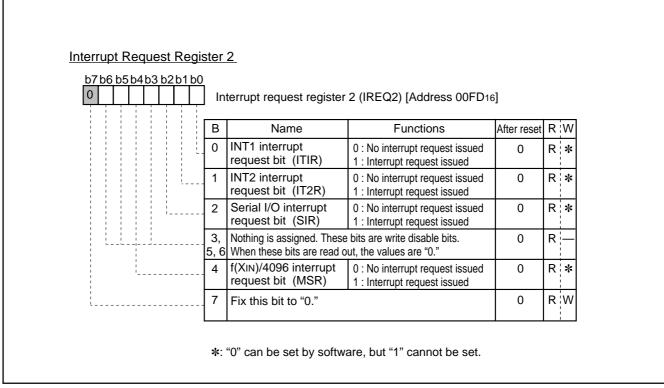


Fig. 11. Interrupt Request Register 2



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

b7 b6 b5 b4 b3 b2 b1 b0	In	terrupt control register 1 (I	CON1) [Address 00FE	16]		
	в	Name	Functions	After reset	R	W
	0	Timer 1 interrupt enable bit (TM1E)	0 : Interrupt disabled 1 : Interrupt enabled	0		W
	1	Timer 2 interrupt enable bit (TM2E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
· · · · · · · · · · · · · · · · · · ·	2	Timer 3 interrupt enable bit (TM3E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	3	Timer 4 interrupt enable bit (TM4E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	4	CRT interrupt enable bit (CRTE)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	5	Vsync interrupt enable bit (VSCE)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
<u> </u>	6	Nothing is assigned. This bit. When this bit is read of		0	R	—
	7	INT3 interrupt enable bit (IN3E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W

Fig. 12. Interrupt Control Register 1

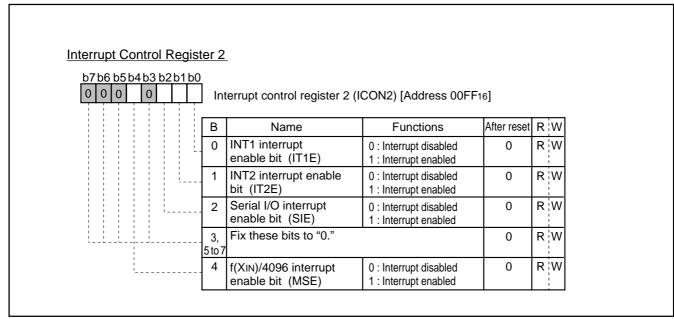


Fig. 13. Interrupt Control Register 2



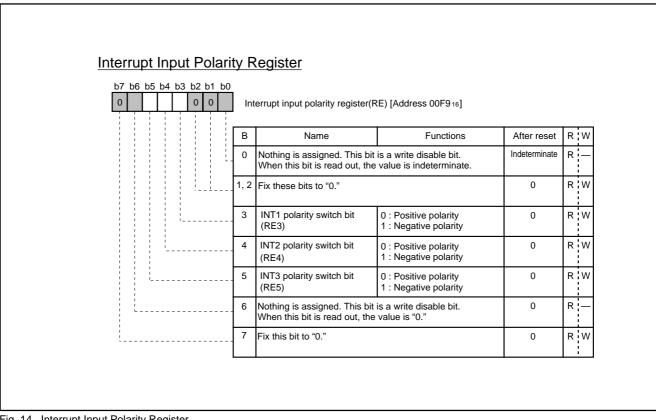


Fig. 14. Interrupt Input Polarity Register



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

TIMERS

The M37224M3-XXXSP has 4 timers: timer 1, timer 2, timer 3, and timer 4. All timers are 8-bit timer with the 8-bit timer latch. The timer block diagram is shown in Figure 17.

All of the timers count down and their divide ratio is 1/(n+1), where n is the value of timer latch. By writing a count value to the corresponding timer latch (addresses 00F016 to 00F316), the value is also set to a timer, simultaneously.

The count value is decremented by 1. The timer interrupt request bit is set to "1" by a timer overflow at the next count pulse, after the count value reaches "0016".

(1) Timer 1

Timer 1 can select one of the following count sources:

- f(XIN)/16
- f(XIN)/4096

The count source of timer 1 is selected by setting bit 0 of the timer 12 mode register (address 00F416).

Timer 1 interrupt request occurs at timer 1 overflow.

(2) Timer 2

Timer 2 can select one of the following count sources:

- f(XIN)/16
- Timer 1 overflow signal
- External clock from the TIM2 pin

The count source of timer 2 is selected by setting bits 1 and 4 of timer 12 mode register (address 00F416). When timer 1 overflow signal is a count source for timer 2, timer 1 functions as an 8-bit prescaler.

Timer 2 interrupt request occurs at timer 2 overflow.

(3) Timer 3

Timer 3 can select one of the following count sources:

- f(XIN)/16
- External clock from the HSYNC pin
- External clock from the TIM3 pin

The count source of timer 3 is selected by setting bits 0 and 5 of timer 34 mode register (address $00F5_{16}$)

Timer 3 interrupt request occurs at timer 3 overflow.

(4) Timer 4

Timer 4 can select one of the following count sources:

- f(XIN)/16
- f(XIN)/2
- Timer 3 overflow signal

The count source of timer 3 is selected by setting bits 1 and 4 of timer 34 mode register (address 00F516). When timer 3 overflow signal is a count source for timer 4, timer 3 functions as an 8-bit prescaler.

Timer 4 interrupt request occurs at timer 4 overflow.

At reset, timers 3 and 4 are connected by hardware and "FF16" is automatically set in timer 3; "0716" in timer 4. The f(XIN)/16 is selected as the timer 3 count source. The internal reset is released by timer 4 overflow in this state and the internal clock is connected.

At execution of the STP instruction, timers 3 and 4 are connected by hardware and "FF16" is automatically set in timer 3; "0716" in timer 4. However, the f(XIN)/16 is not selected as the timer 3 count source. So set bit 0 of timer 34 mode register (address 00F516) to "0" before execution of the STP instruction (f(XIN)/16 is selected as the timer 3 count source). The internal STP state is released by timer 4 overflow in this state and the internal clock is connected.

As a result of the above procedure, the program can start under a stable clock.

Timer-related registers are shown in Figures 15 and 16.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

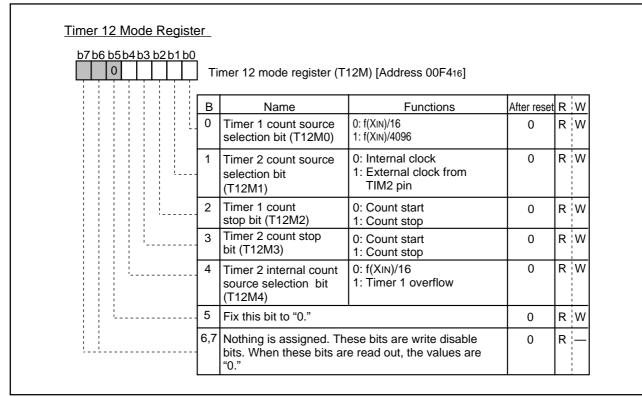


Fig. 15. Timer 12 Mode Register

b7 b6 b5 b4 b	b3 b2 b1 b0	Ti	mer 34 mode register (T3	34M) [Address 00F516]			
		В	Name	Functions	After reset	R	W
		0	Timer 3 count source selection bit (T34M0)	0: f(XIN)/16 1: External clock	0	R	W
		1	Timer 4 internal count source selection bit (T34M1)	0: Timer 3 overflow 1: f(XIN)/16	0	R	W
		2	Timer 3 count stop bit (T34M2)	0: Count start 1: Count stop	0	R	W
		3	Timer 4 count stop bit (T34M3)	0: Count start 1: Count stop	0	R	W
· · · · · · · · · · · · · · · · · · ·		4	Timer 4 count source selection bit (T34M4)	0: Internal clock 1: f(XIN)/2	0	R	W
		5	Timer 3 external count source selection bit (T34M5)	0: External clock from TIM3 pin 1: External clock from H sync pin	0	R	W
		6,7		ese bits are write disable e read out, the values are	0	R	_

Fig. 16. Timer 34 Mode Register



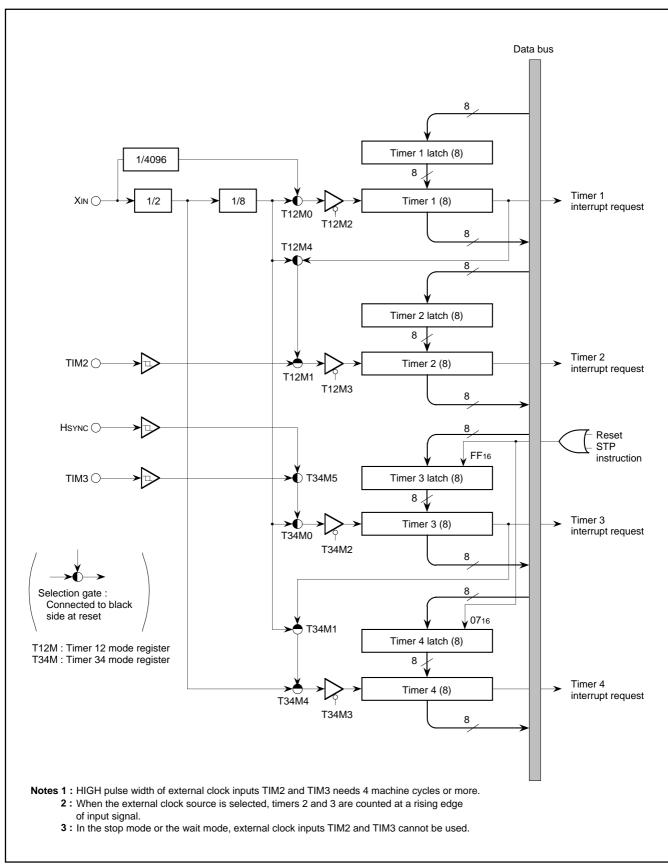


Fig. 17. Timer Block Diagram



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SERIAL I/O

The M37224M3-XXXSP has a built-in serial I/O which can either transmit or receive 8-bit data serially in the clock synchronous mode.

The serial I/O block diagram is shown in Figure 18. The synchronous clock I/O pin (SCLK), and data I/O pins (SOUT, SIN) also function as port P2.

Bit 2 of the serial I/O mode register (address 00DC16) selects whether the synchronous clock is supplied internally or externally (from the P20/SCLK pin). When an internal clock is selected, bits 1 and 0 select whether f(XIN) is divided by 4, 16, 32, or 64. Bit 3 selects whether port P2 is used for serial I/O or not. To use the P22/SIN pin as the SIN pin, set the bit 2 of the port P2 direction register (address 00C516) to "0."

The operation of the serial I/O is described below. The operation differs depending on the clock source; external clock or internal clock.

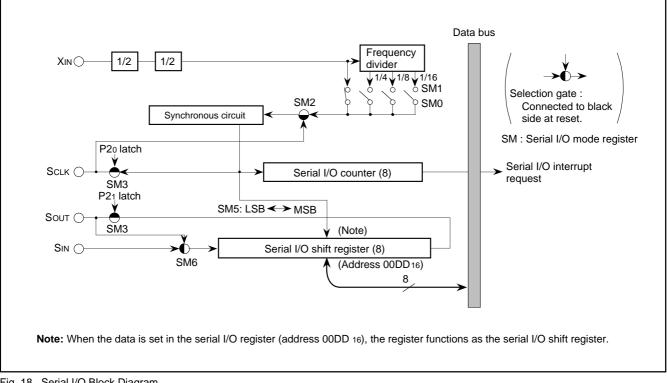


Fig. 18. Serial I/O Block Diagram



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Internal clock: The serial I/O counter is set to "7" during the write cycle into the serial I/O register (address 00DD16), and the transfer clock goes "H" forcibly. At each falling edge of the transfer clock after the write cycle, serial data is output from the SOUT pin. Transfer direction can be selected by bit 5 of the serial I/O mode register. At each rising edge of the transfer clock, data is input from the SIN pin and data in the serial I/O register is shifted 1 bit.

After the transfer clock has counted 8 times, the serial I/O counter becomes "0" and the transfer clock stops at HIGH. At this time the interrupt request bit is set to "1."

External clock: When an external clock is selected as the clock source, the interrupt request is set to "1" after the transfer clock has been counted 8 counts. However, transfer operation does not stop, so the clock should be controlled externally. Use the external clock of 1MHz or less with a duty cycle of 50%.

The serial I/O timing is shown in Figure 19. When using an external clock for transfer, the external clock must be held at HIGH for initializing the serial I/O counter. When switching between an internal clock and an external clock, do not switch during transfer. Also, be sure to initialize the serial I/O counter after switching.

- Notes 1: On programming, note that the serial I/O counter is set by writing to the serial I/O register with the bit managing instructions, such as SEB and CLB.
 - 2: When an external clock is used as the synchronous clock, write transmit data to the serial I/O register when the transfer clock input level is HIGH.

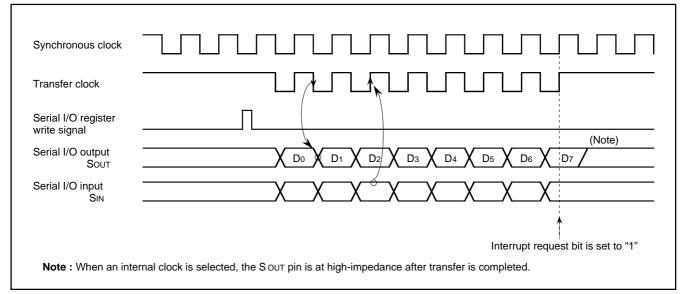


Fig. 19. Serial I/O Timing (for LSB first)



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b7b6 b5 b4 b3 b2 b1 b0	S	erial I/O mode register (SM) [Address 00DC16]			
	В	Name	Functions	After reset	R	N
· · · · · · · · · · · · · · · · · · ·	0, 1	Internal synchronous clock selection bits (SM0, SM1)	b1 b0 0 0: f(XIN)/4 0 1: f(XIN)/16 1 0: f(XIN)/32 1 1: f(XIN)/64	0	R	V
	2	Synchronous clock selection bit (SM2)	0: External clock 1: Internal clock	0	R	W
· · · · · · · · · · · · · · · · · · ·	3	Serial I/O port selection bit (SM3)	0: P20, P21 functions as port 1: ScLK, So∪⊤	0	R	W
	4	Fix this bit to "0."		0	R	W
	5	Transfer direction selection bit (SM5)	0: LSB first 1: MSB first	0	R	N
	6	Serial input pin selection bit (SM6)	0: Input signal from SIN pin 1: Input signal from SOUT pin	0	R	W
	7	Nothing is assigned. The When this bit is read o	his bit is a write disable bit. ut, the value is "0."	0	R	

Fig. 20. Serial I/O Mode Register

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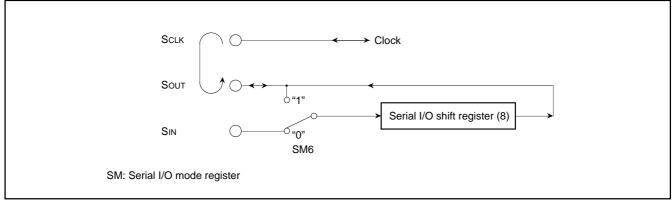
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Serial I/O Common Transmission/Reception Mode

By writing "1" to bit 6 of the serial I/O mode register, signals SIN and SOUT are switched internally to be able to transmit or receive the serial data.

Figure 21 shows signals on serial I/O common transmission/reception mode.

Note: When receiving the serial data after writing "FF16" to the serial I/O register.







PWM OUTPUT FUNCTION

The M37224M3-XXXSP is equipped with a 14-bit PWM (DA) and six 8-bit PWMs (PWM0–PWM5). DA has a 14-bit resolution with the minimum resolution bit width of 0.25 μ s and a repeat period of 4096 μ s (for f(XIN) = 8 MHz). PWM0–PWM5 have the same circuit structure and an 8-bit resolution with minimum resolution bit width of 4 μ s and repeat period of 1024 μ s (for f(XIN) = 8 MHz).

Figure 22 shows the PWM block diagram. The PWM timing generating circuit applies individual control signals to PWM0–PWM5 using f(XIN) divided by 2 as a reference signal.

(1) Data Setting

When outputting DA, first set the high-order 8 bits to the DA-H register (address 00CE16), then the low-order 6 bits to the DA-L register (address 00CF16). When outputting PWM0–PWM5, set 8-bit output data to the PWMi register (i means 0 to 5; addresses 00D016 to 00D416, 00F616).

(2) Transmitting Data from Register to PWM circuit

Data transfer from the 8-bit PWM register to the 8-bit PWM circuit is executed at writing data to the register.

The signal output from the 8-bit PWM output pin corresponds to the contents of this register.

Also, data transfer from the DA register (addresses 00CE16 and 00CF16) to the 14-bit PWM circuit is executed at writing data to the DA-L register (address 00CF16). Reading from the DA-H register (address 00CE16) means reading this transferred data. Accordingly, it is possible to confirm the data being output from the D-A output pin by reading the DA register.

(3) Operating of 8-bit PWM

The following explains PWM operation.

First, set the bit 0 of PWM output control register 1 (address 00D516) to "0" (at reset, this bit 0 already set to "0" automatically), so that the PWM count source is supplied.

PWM0–PWM5 are also used as pins P00–P05 respectively. For PWM0–PWM5, set the corresponding bits of the port P0 direction register to "1" (output mode). And select each output polarity by bit 3 of PWM output control register 2(address 00D616). Then, set bits 2 to 7 of PWM output control register 1 to "1" (PWM output).

The PWM waveform is output from the PWM output pins by setting these registers.

Figure 23 shows the 8-bit PWM timing. One cycle (T) is composed of 256 (2⁸) segments. The 8 kinds of pulses, relative to the weight of each bit (bits 0 to 7), are output inside the circuit during 1 cycle. Refer to Figure 23 (a). The 8-bit PWM outputs waveform performed a OR operation of pulses corresponding to the contents of bits 0 to 7 of the 8-bit PWM register. Several examples are shown in Figure 23 (b). 256 kinds of output (HIGH area: 0/256 to 255/256) are selected by changing the contents of the PWM register. A length of entirely HIGH cannot be output, i.e. 256/256.

(4) Operating of 14-bit PWM

As with 8-bit PWM, set the bit 0 of the PWM output control register 1 (address 00D516) to "0" (at reset, bit 0 is already set to "0" automatically), so that the PWM count source is supplied. Next, select the output polarity by bit 2 of PWM output control register 2 (address 00D616). Then, the 14-bit PWM outputs from the D-A output pin by setting bit 1 of PWM output control register 1 to "0" (at reset, this bit already set to "0" automatically) to select the DA output.

The output example of the 14-bit PWM is shown in Figure 24.

The 14-bit PWM divides the data of the DA latch into the low-order 6 bits and the high-order 8 bits.

The fundamental waveform is determined with the high-order 8-bit data "DH." A "H" level area with a length $\tau \times DH$ ("H" level area of fundamental waveform) is output every short area of "t" = $256\tau = 64 \ \mu s$ (τ is the minimum resolution bit width of 0.25 μs). The "H" level area increase interval (tm) is determined with the low-order 6-bit data "DL." The "H" level are of smaller intervals "tm" shown in Table 6 is longer by τ than that of other smaller intervals in PWM repeat period "T" = 64t. Thus, a rectangular waveform with the different "H" width is output from the D-A pin. Accordingly, the PWM output changes by τ unit pulse width by changing the contents of the DA-H and DA-L registers. A length of entirely "H" output cannot be output, i. e. 256/ 256.

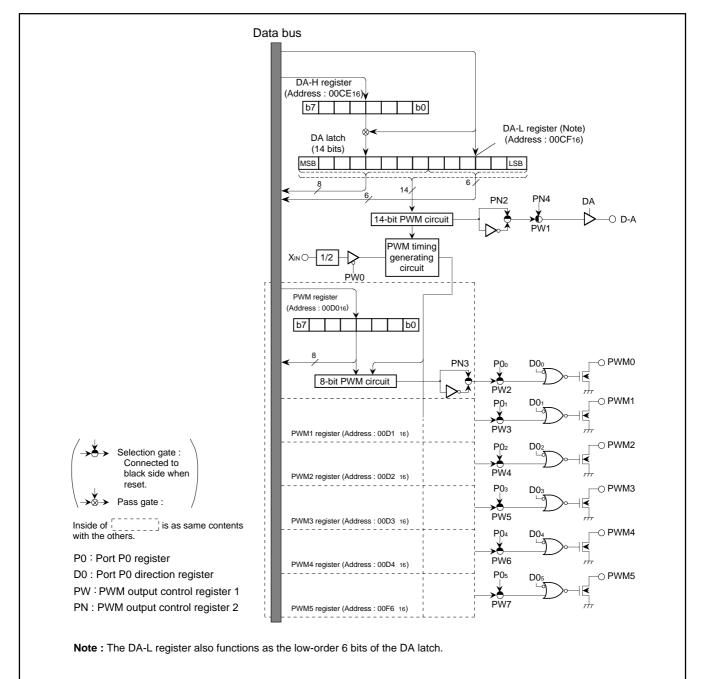
(5) Output after Reset

At reset the output of port P00–P05 is in the high-impedance state, and the contents of the PWM register and the PWM circuit are undefined. Note that after reset, the PWM output is undefined until setting the PWM register.



Table 2. Relation between Low-order 6-bit Data and High-level Area Increase Interval

Low-order 6 Bits of Data	Area Longer by τ than That of Other tm (m = 0 to 63)
0 0 0 0 0 0 ^{LSB}	Nothing
000001	m = 32
000010	m = 16, 48
000100	m = 8, 24, 40, 56
001000	m = 4, 12, 20, 28, 36, 44, 52, 60
010000	m=2,6,10,14,18,22,26,30,34,38,42,46,50,54,58,62
100000	m = 1, 3, 5, 7, 57, 59, 61, 63

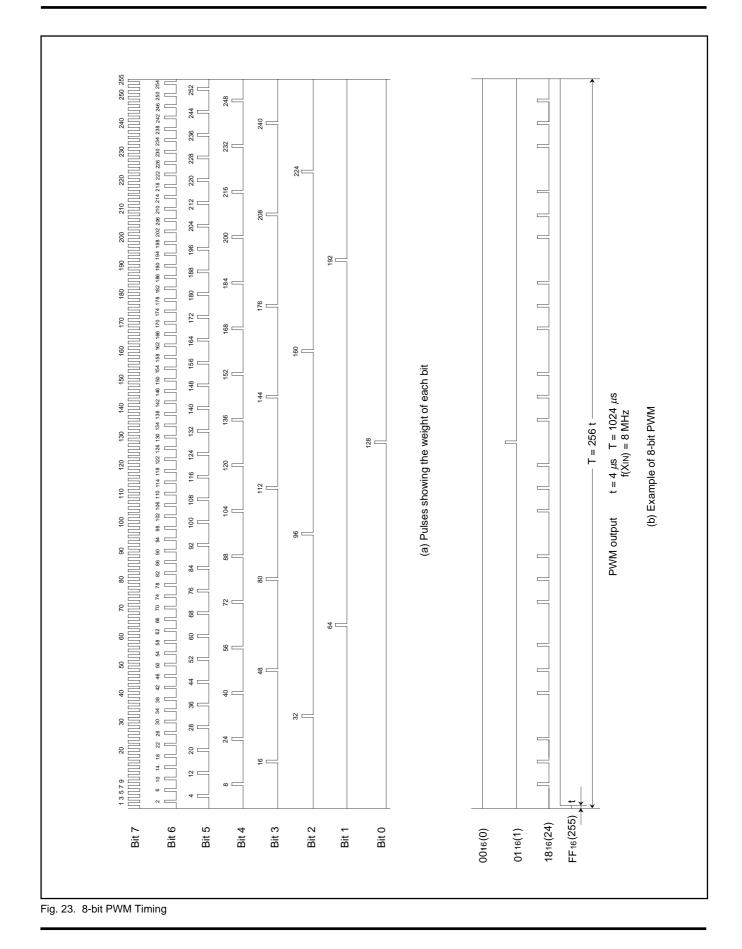




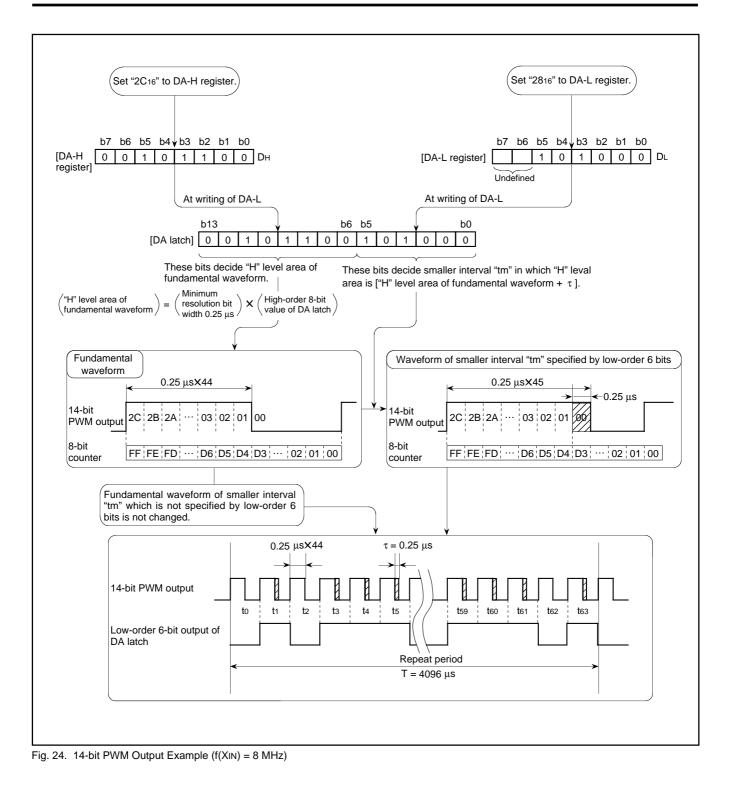


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b7b6b5b4b3b2b1b0	P١	WM output control registe	er 1 (PW) [Address 00D516]			
	В	Name	Functions	After reset	R	W
	0	DA, PWM count source selection bit (PW0)	0 : Count source supply 1 : Count source stop	0	R	W
	1	DA/PN4 output selection bit (PW1)	0 : DA output 1 : PN4 output	0	R	W
	2	P00/PWM0 output selection bit (PW2)	0: P0o output 1: PWM0 output	0	R	W
	3	P01/PWM1 output selection bit (PW3)	0: P01 output 1: PWM1 output	0	R	W
· · · · · · · · · · · · · · · · · · ·	4	P02/PWM2 output selection bit (PW4)	0: P02 output 1: PWM2 output	0	R	W
· · · · · · · · · · · · · · · · · · ·	5	P03/PWM3 output selection bit (PW5)	0: P03 output 1: PWM3 output	0	R	W
	6	P04/PWM4 output selection bit (PW6)	0: P04 output 1: PWM4 output	0	R	W
l	7	P05/PWM5 output selection bit (PW7)	0: P05 output 1: PWM5 output	0	R	W

Fig. 25. PWM Output Control Register 1

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PWM Output Control R	•				
b7b6b5b4b3b2b1b		WM output control regis	er 2 (PN) [Address 00D616]		
	В	Name	Functions	After reset	RW
	<u> </u> 0, 1	Nothing is assigned. The When these bits are re	0	R —	
	2	DA output polarity selection bit (PN3)	0 : Positive polarity 1 : Negative polarity	0	RW
	3	PWM output polarity selection bit (PN4)	0 : Positive polarity 1 : Negative polarity	0	RW
· · · · · · · · · · · · · · · · · · ·	4	DA general-purpose output bit (PN5)	0 : Output LOW 1 : Output HIGH	0	RW
	5 to 7	Nothing is assigned. Th When these bits are re	0	R —	

Fig. 26. PWM Output Control Register 2



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A-D COMPARATOR

A-D comparator consists of 6-bit D-A converter and comparator. A-D comparator block diagram is shown in Figure 27.

The reference voltage "Vref" for D-A conversion is set by bits 0 to 5 of the A-D control register 2 (address 00EF16).

The comparison result of the analog input voltage and the reference voltage "Vref" is stored in bit 4 of the A-D control register 1 (address 00EE16).

For A-D comparison, set "0" to corresponding bits of the direction register to use ports as analog input pins. Write the data for select of analog input pins to bits 0 to 2 of the A-D control register 1 and write the digital value corresponding to Vref to be compared to the bits 0 to 5 of the A-D control register 2. The voltage comparison starts by writing to the A-D control register 2, and it is completed after 16 machine cycles (NOP instruction X 8).

Table 3. Relation between Contents of A-D Control Register 2 and Reference Voltage "Vref"

	A-D	Reference				
Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Voltage "Vref"
0	0	0	0	0	0	1/128 Vcc
0	0	0	0	0	1	3/128 Vcc
0	0	0	0	1	0	5/128 Vcc
:	÷	:	:	:		
1	1	1	1	0	1	123/128 Vcc
1	1	1	1	1	0	125/128 Vcc
1	1	1	1	1	1	127/128 Vcc

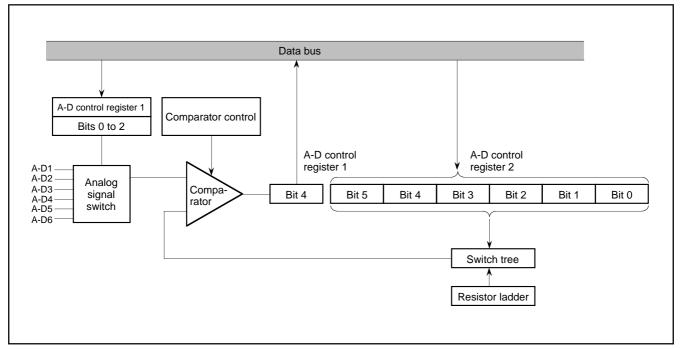


Fig. 27. A-D Comparator Block Diagram



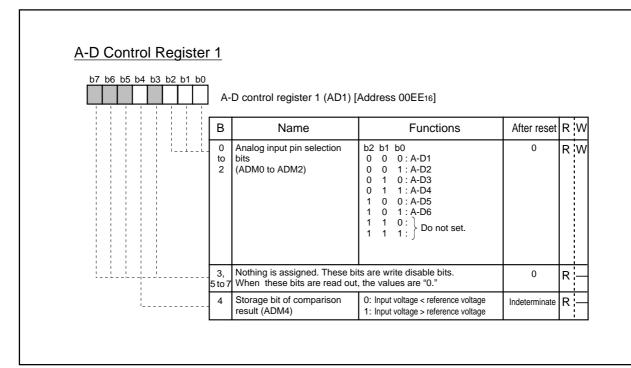


Fig. 28. A-D Control Register 1

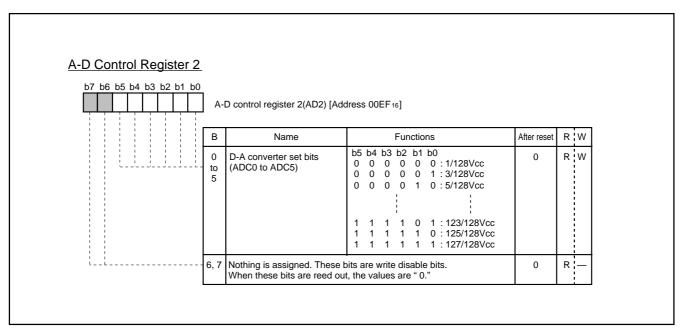


Fig. 29. A-D Control Register 2



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D-A CONVERTER

The M37224M3-XXXSP has 2 D-A converters with 6-bit resolution. D-A converter block diagram is shown in Figure 30.

D-A conversion is performed by setting the value in the DA conversion register. The result of D-A conversion is output from the DA pin by setting "1" to the DA output enable bit of the port P3 output mode control register (bits 2 and 3 at address 00CD16).

The output analog voltage V is determined with the value n (n: decimal number) in the DA conversion register.

V = Vcc X
$$\frac{n}{128}$$
 (n = 0 to 127)

The DA output does not build in a buffer, so connect an external buffer when driving a low-impedance load.

 Table 4.
 Relation between Contents of D-A Conversion Register and Output Voltage

	D	Output					
Bit 7	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Voltage "V"
0	0	0	0	0	0	0	0/128 Vcc
1	0	0	0	0	0	0	1/128 Vcc
0	0	0	0	0	0	1	2/128 Vcc
:	:	:	:	:	:	÷	:
1	1	1	1	1	1	0	125/128 Vcc
0	1	1	1	1	1	1	126/128 Vcc
1	1	1	1	1	1	1	127/128 Vcc

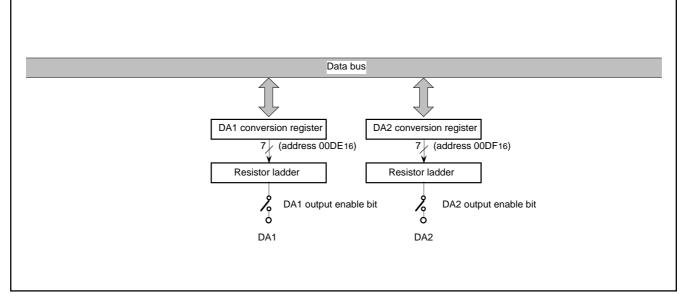


Fig. 30. D-A Converter Block Diagram



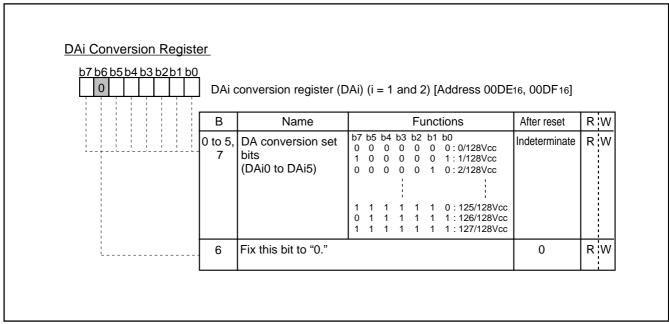


Fig. 31. DAi Conversion Register

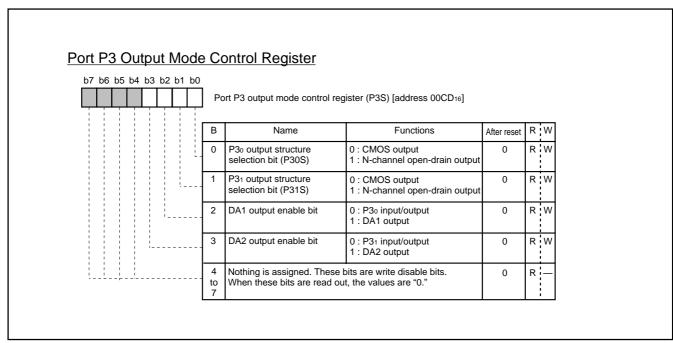


Fig. 32. Port P3 Output Mode Control Register



CRT DISPLAY FUNCTIONS

(1) Outline of CRT Display Functions

Table 5 outlines the CRT display functions of the M37224M3-XXXSP. The M37224M3-XXXSP incorporates a CRT display circuit of 20 characters X 2 lines. CRT display is controlled by the CRT control register. Up to 128 kinds of characters can be displayed. The colors can be specified for each character and up to 4 kinds of colors can be displayed on one screen. A combination of up to 7 colors can be obtained by using each output signal (R, G, and B).

Characters are displayed in a 12 X 16 dots configuration to obtain smooth character patterns (refer to Figure 33).

The following shows the procedure how to display characters on the CRT screen.

- ① Write the display character code in the display RAM.
- ⁽²⁾ Specify the display color by using the color register.
- ③ Write the color register in which the display color is set in the display RAM.
- ④ Specify the vertical position by using the vertical position register.
- 5 Specify the character size by using the character size register.
- ⑥ Specify the horizontal position by using the horizontal position register.
- ⑦ Write the display enable bit to the designated block display flag of the CRT control register. When this is done, the CRT display starts according to the input of the VSYNC signal.

The CRT display circuit has an extended display mode. This mode allows multiple lines (3 lines or more) to be displayed on the screen by interrupting the display each time one line is displayed and rewriting data in the block for which display is terminated by software. Figure 34 shows the CRT display control register. Figure 35 shows the block diagram of the CRT display circuit.

Table 5. Outline of CRT Display Functions

Par	ameter	Functions			
Number of display characters		20 characters X 2 lines			
Dot structure		12 X 16 dots (refer to Figure 33)			
Kinds of cl	naracters	128 kinds			
Kinds of character sizes		3 kinds			
Color	Kinds of colors	1 screen: 4 kinds, maximum 7 kinds			
000	Coloring unit	A character			
Display ex	pansion	Possible (multiline display)			
Raster coloring		Possible (maximum 7 kinds)			



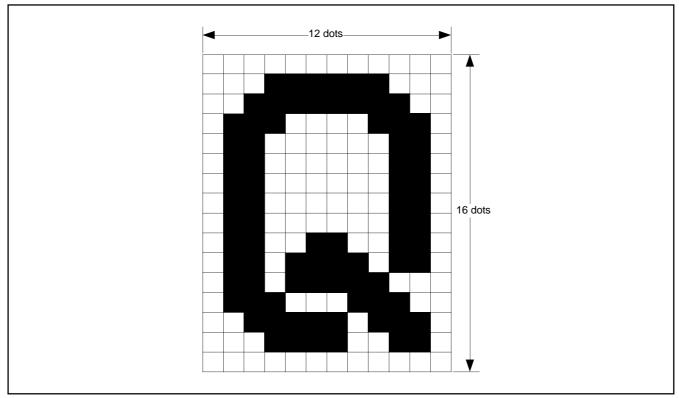
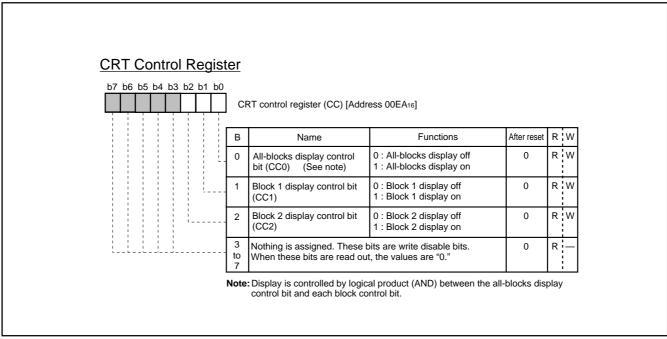
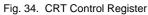


Fig. 33. CRT Display Character Configuration







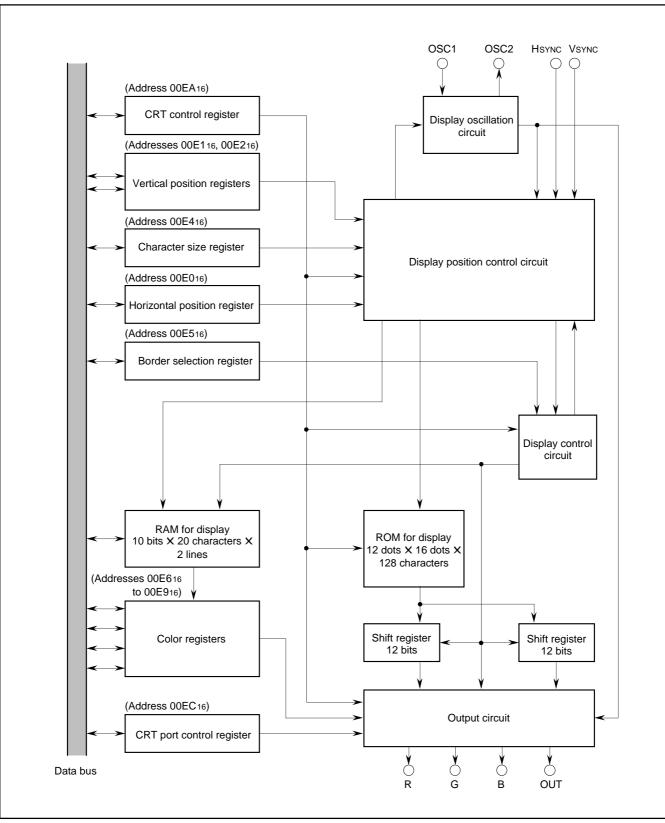


Fig. 35. Block Diagram of CRT Display Circuit



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(2) Display Position

The display positions of characters are specified in units called a "block." There are 2 blocks, block 1 and block 2. Up to 20 characters can be displayed in each block (refer to (4) Memory for Display).

The display position of each block can be set in both horizontal and vertical directions by software.

The display position in the horizontal direction can be selected for all blocks in common from 64-step display positions in units of 4Tc (Tc = oscillating cycle for display).

The display position in the vertical direction for each block can be selected from 128-step display positions in units of 4 scanning lines.

Block 2 is displayed after the display of block 1 is completed (refer to Figure 36 (a)). Accordingly, if the display of block 2 starts during the display of block 1, only block 1 is displayed. Similarly, when multiline display, block 1 is displayed after the display of block 2 is completed (refer to Figure 36 (b)).

The vertical position can be specified from 128-step positions (4 scanning lines per a step) for each block by setting values "0016" to "7F16" to bits 0 to 6 in the vertical position register (addresses 00E116 and 00E216). Figure 38 shows the structure of the vertical position register.

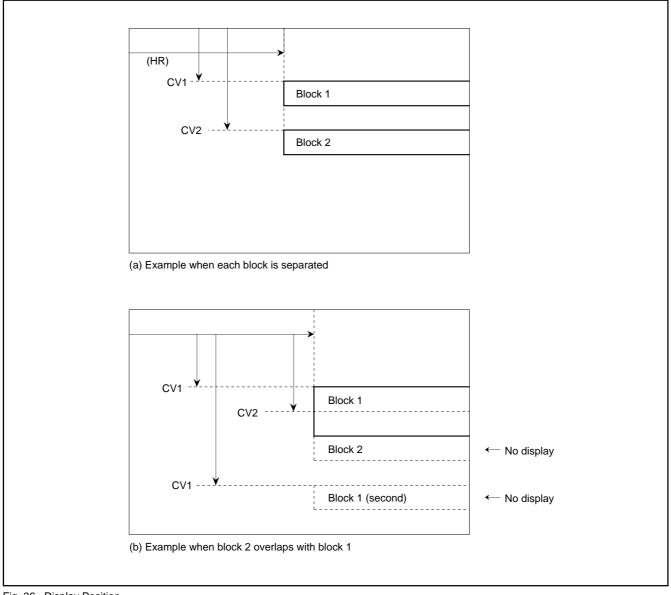


Fig. 36. Display Position



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The display position in the vertical direction is determined by counting the horizontal sync signal (HSYNC). At this time when VSYNC and HSYNC are positive polarity (negative polarity), it starts to count the rising edge (falling edge) of HSYNC signal from after about 1 machine cycle of rising edge (falling edge) of VSYNC signal. So interval from rising edge (falling edge) of VSYNC signal to rising edge (falling edge) of HSYNC signal needs enough time (2 machine cycles or more) for avoiding jitter. The polarity of HSYNC and VSYNC signals can select with the CRT port control register (address 00EC16).

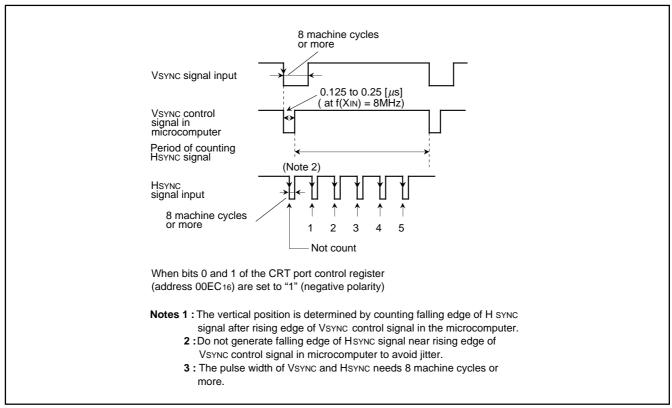
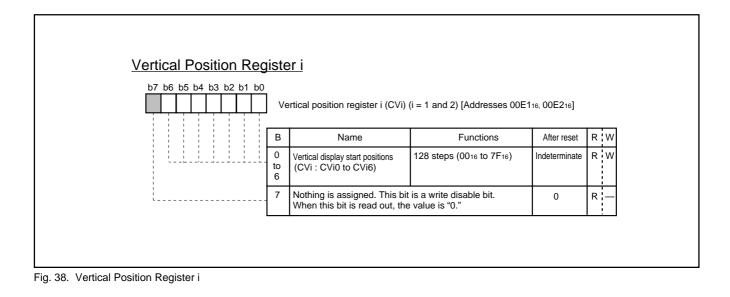


Fig. 37. Supplement Explanation for Display Position





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The horizontal position is common to all blocks, and can be set in 64 steps (where 1 step is 4Tc, Tc being the display oscillation period) as values "0016" to "3F16" in bits 0 to 5 of the horizontal position register (address 00E016). The structure of the horizontal position register is shown in Figure 39.

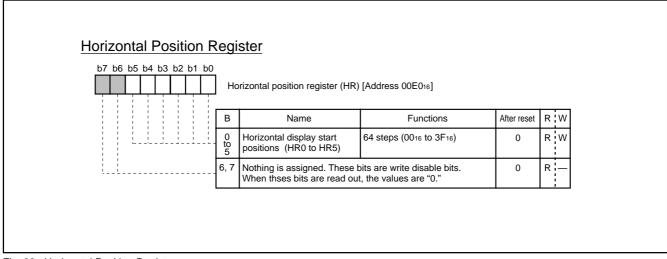


Fig. 39. Horizontal Position Register



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(3) Character Size

The size of characters to be displayed can be from 3 sizes for each block. Use the character size register (address 00E416) to set a character size. The character size of block 1 can be specified by using bits 0 and 1 of the character size register; the character size of block 2 can be specified by using bits 2 and 3. Figure 40 shows the character size register.

The character size can be selected from 3 sizes: minimum size, medium size and large size. Each character size is determined by the number of scanning lines in the height (vertical) direction and the oscillating cycle for display (Tc) in the width (horizontal) direction. The minimum size consists of [1 scanning line] \times [1Tc]; the medium size consists of [2 scanning lines] \times [2Tc]; and the large size consists of [3 scanning lines] \times [3Tc]. Table 6 shows the relation between the set values in the character size register and the character sizes.

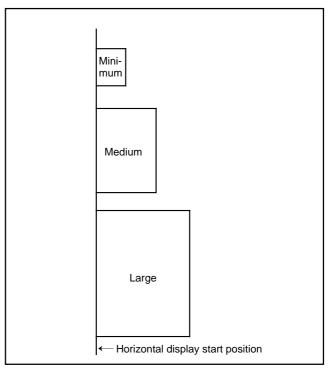


Fig. 41. Display Start Position of each Character Size (horizontal direction)

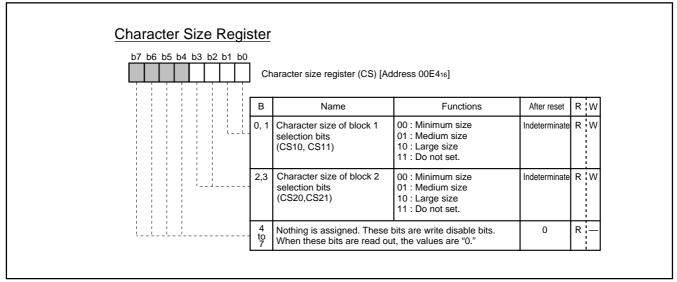


Fig. 40. Character Size Register

Table 6. Relation between Set Values in Character Size Register and Character Sizes

Set Values of Cha	Set Values of Character Size Register		Width (horizontal) Direction	Height (vertical) Direction		
CSn1	CSn0	Size	Tc: oscillating cycle for display	Scanning Lines		
0	0	Minimum	1Tc	1		
0	1	Medium	2Tc	2		
1	0	Large	3Tc	3		
1	1	This is not available				

Note: The display start position in the horizontal direction is not affected by the character size. In other words, the horizontal display start position is common to all blocks even when the character size varies with each block (refer to Figure 41).



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(4) Memory for Display

There are 2 types of display memory : CRT display ROM (addresses 1000016 to 10FFF16) used to store character dot data (masked) and CRT display RAM (addresses 060016 to 06B316) used to specify the colors of characters to be displayed. The following describes each type of display memory.

① ROM for display (addresses 1000016 to 10FFF16)

The CRT display ROM contains dot pattern data for characters to be displayed. For characters stored in this ROM to be actually displayed, it is necessary to specify them by writing the character code inherent to each character (code determined based on the addresses in the CRT display ROM) into the CRT display RAM. The character code list is shown in Table 7.

The CRT display ROM has a capacity of 4 K bytes. Since 32 bytes are required for 1 character data, the ROM can stores up to 128 kinds of characters.

The CRT display ROM space is broadly divided into 2 areas. The [vertical 16 dots] X [horizontal (left side) 8 dots] data of display characters are stored in addresses 1000016 to 107FF16; the [vertical 16 dots] X [horizontal (right side) 4 dots] data of display characters are stored in addresses 1080016 to 10FFF16 (refer to Figure 42). Note however that the high-order 4 bits in the data to be written to addresses 1080016 to 10FFF16 must be set to "1" (by writing data "FX16").

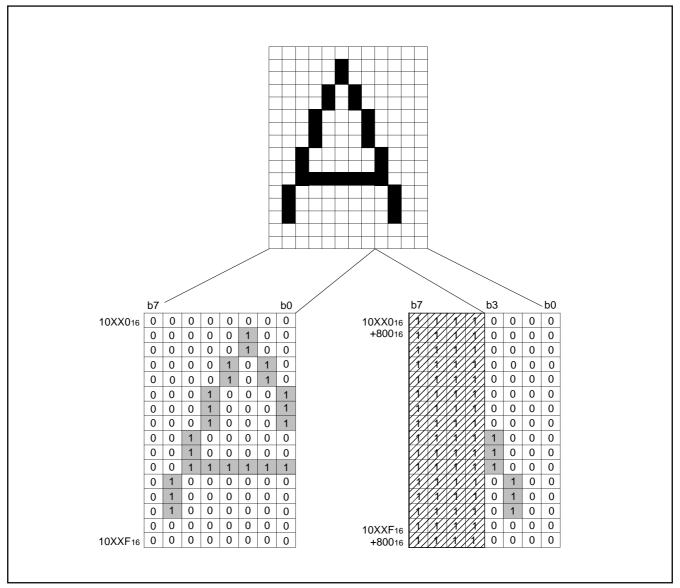


Fig. 42. Display Character Stored Data



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Character code	Character data	storage address
	Left 8 dots lines	Right 4 dots lines
	1000016	1080016
0016	to	to
	1000F16	1080F16
	1001016	1081016
0116	to	to
	1001F16	1081F16
	1002016	1082016
0216	to	to
	1002F16	1082F16
	1003016	1083016
0316	to	to
	1003F16	1083F16
:	:	:
	107E016	10FE016
7E16	to	to
	107EF16	10FEF16
	107F016	10FF016
7F16	to	to
	107FF16	10FFF16

Table 7. Character Code List (partially abbreviated)

2 RAM for display (addresses 060016 to 06B316)

The CRT display RAM is allocated at addresses 060016 to 06B316, and is divided into a display character code specification part and display color specification part for each block. Table 8 shows the contents of the CRT display RAM.

For example, to display 1 character position (the left edge) in block 1, write the character code in address 060016 and write the color register No. to the low-order 2 bits (bits 0 and 1) in address 068016. The color register No. to be written here is one of the 4 color registers in which the color to be displayed is set in advance. For details on color registers, refer to (5) Color Registers. The structure of the CRT display RAM is shown in Figure 43.

Table 8. Contents of CRT Display RAM

Block	Display Position (from left)	Character Code Specification	Color Specification
	1st character	060016	068016
	2nd character	060116	068116
	3rd character	060216	068216
Block 1	:	:	:
	18th character	061116	069116
	19th character	061216	069216
	20th character	061316	069316
		061416	069416
	Not used	to	to
		061F16	069F16
	1st character	062016	06A016
	2nd character	062116	06A116
	3rd character	062216	06A216
Block 2	:	:	:
	18th character	063116	06B116
	19th character	063216	06B216
	20th character	063316	06B316



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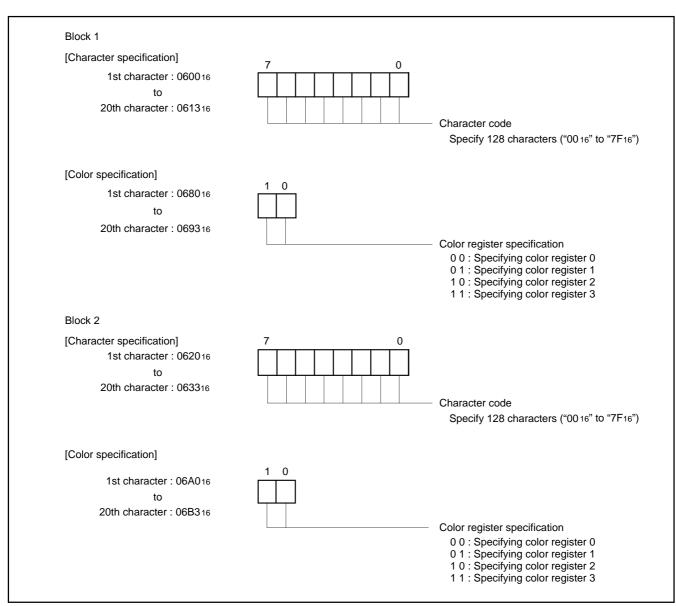


Fig. 43. Structure of CRT Display RAM



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

(5) Color Registers

The color of a displayed character can be specified by setting the color to one of the 4 registers (CO0 to CO3: addresses 00E616 to 00E916) and then specifying that color register with the CRT display RAM. There are 3 color outputs; R, G and B. By using a combination of these outputs, it is possible to set 2^3 -1 (when no output) = 7 colors. However, since only 4 color registers are available, up to 4 colors can be disabled at one time.

R, G and B outputs are set by using bits 1 to 3 in the color register. Bit 5 is used to specify whether a character output or blank output. Figure 44 shows the color register.

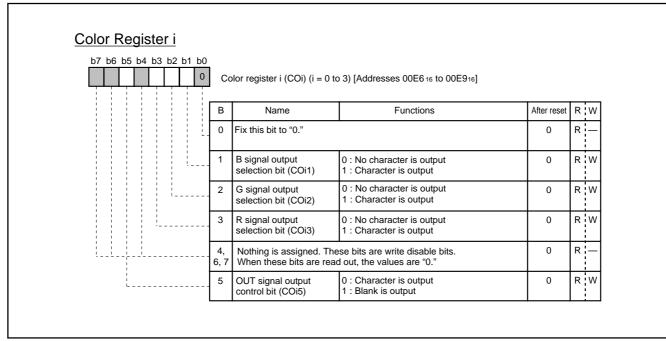


Fig. 44. Color Registers



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

(6) Character Border Function

An border of 1 clock (1 dot) equivalent size can be added to a character to be displayed in both horizontal and vertical directions. The border is output from the OUT pin. In this case, set bit 5 of a color register to "0" (character is output).

Border can be specified in units of block by using the border selection register (address 00E516). Figure 45 shows the border selection register. Table 9 shows the relationship between the values set in the border selection register and the character border function.

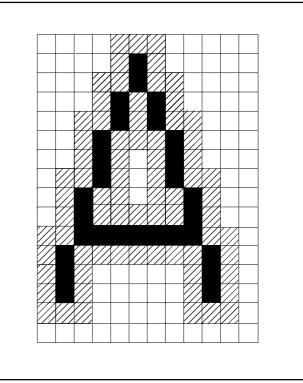


Fig. 46. Example of Border

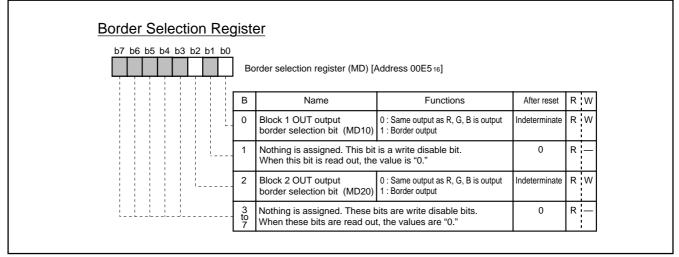


Fig. 45. Border Selection Register

Table 9. Relationship between Set Value in Border Selection Register and Character Border Function

Border Selection Register MDn0	Functions	Example of Output
0	Ordinary	R, G, B output OUT output
1	Border including character	R, G, B output OUT output



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

(7) Multiline Display

The M37224M3-XXXSP can ordinarily display 2 lines on the CRT screen by displaying 2 blocks at different vertical positions. In addition, it can display up to 16 lines by using CRT interrupts.

A CRT interrupt request occurs at the point at which display of each block has been completed. In other words, when a scanning line reaches the point of the display position (specified by the vertical position registers) of a certain block, the character display of that block starts, and an interrupt occurs at the point at which the scanning line exceeds the block.

Note: A CRT interrupt does not occur at the end of display when the block is not displayed. In other words, if a block is set to off display with the display control bit of the CRT control register (address 00EA16), a CRT interrupt request does not occur (refer to Figure 47).

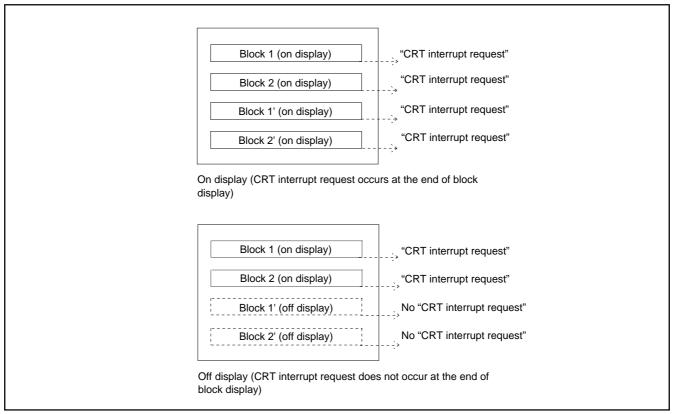


Fig. 47. Timing of CRT Interrupt Request



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

(8) CRT Output Pin Control

The CRT output pins R, G, B, and OUT can also function as ports P52, P53, P54 and P55. Set the corresponding bit of the port P5 direction register (address 00CB16) to "0" to specify these pins as CRT output pins, or set it to "1" to specify it as an general-purpose port P5 pins.

The input polarity of signals HSYNC and VSYNC and output polarity of signals R, G, B, and OUT can be specified with the bits of the CRT port control register (address 00EC16) . Set a bit to "0" to specify positive polarity; set it to "1" to specify negative polarity. The structure of the CRT port control register is shown in Figure 48.

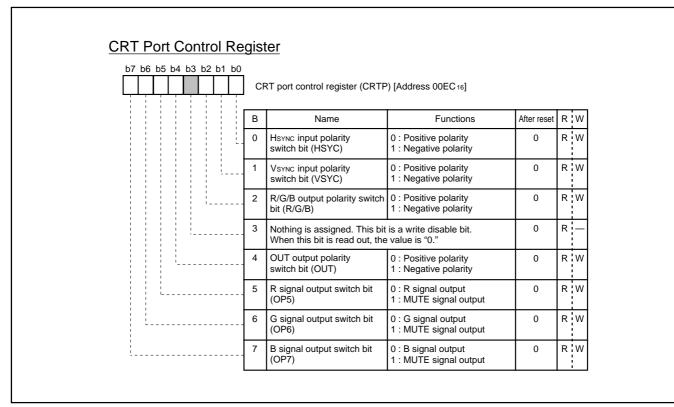


Fig. 48. CRT Port Control Register



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

(9) Raster Coloring Function

An entire screen (raster) can be colored by setting the bits 5 to 7 of the CRT port control register. Since each of the R, G, and B pins can be switched to raster coloring output, 7 raster colors can be obtained. If the R, G, and B pins have been set to MUTE signal output, a raster coloring signal is output in the part except a no-raster colored character (in Figure 49, a character "O") during 1 horizontal scanning period. This ensures that character colors do not mix with the raster color. In this case, MUTE signal is output from the OUT1 pin. An example in which a magenta character "I" and a red character "O" are displayed with blue raster coloring is shown in Figure 49.

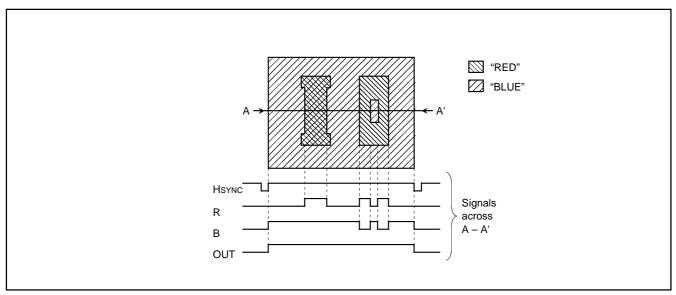


Fig. 49. Example of Raster Coloring



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

(10) Clock for Display

As a clock for display to be used for CRT display, it is possible to select one of the following 4 types.

Main clock supplied from the XIN pin

- Main clock supplied from the XIN pin divided by 1.5
- Clock from the LC or RC supplied from the pins OSC1 and OSC2.
- Clock from the ceramic resonator or quartz-crystal oscillator supplied from the pins OSC1 and OSC2.

This clock for display can be selected for each block by the CRT clock selection register (address 00ED16).

When selecting the main clock, set the oscillation frequency to 8 $\ensuremath{\mathsf{MHz}}$

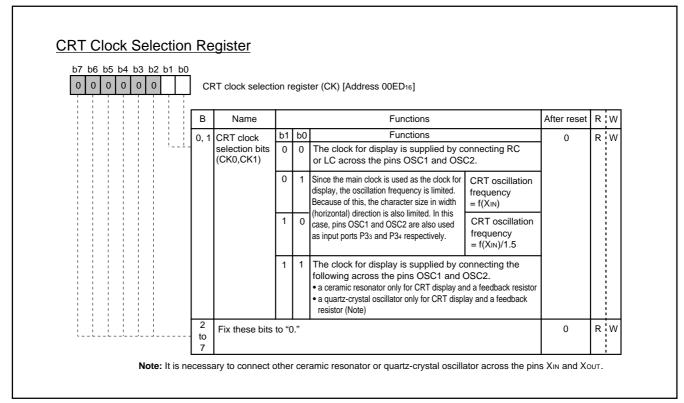


Fig. 50. CRT Clock Selection Register



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

ROM CORRECTION FUNCTION

This can correct program data in ROM. Up to 2 addresses (2 blocks) can be corrected, a program for correction is stored in the ROM correction memory in RAM. The ROM memory for correction is 32 bytes \times 2 blocks.

- Block 1 : addresses 02C016 to 02DF16
- Block 2 : addresses 02E016 to 02FF16

Set the address of the ROM data to be corrected into the ROM correction address register. When the value of the counter matches the ROM data address in the ROM correction address, the main program branches to the correction program stored in the ROM memory for correction. To return from the correction program to the main program, the op code and operand of the JMP instruction (total of 3 bytes) are necessary at the end of the correction program. When the blocks 1 and 2 are used in series, the above instruction is not needed at the end of the block 1.

The ROM correction function is controlled by the ROM correction enable register.

- **Notes 1**: Specify the first address (op code address) of each instruction as the ROM correction address.
 - **2**: Use the JMP instruction (total of 3 bytes) to return from the main program to the correction program.
 - **3** : Do not set the same ROM correction address to the blocks 1 and 2.

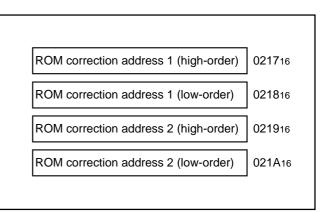


Fig. 51. ROM Correction Address Registers

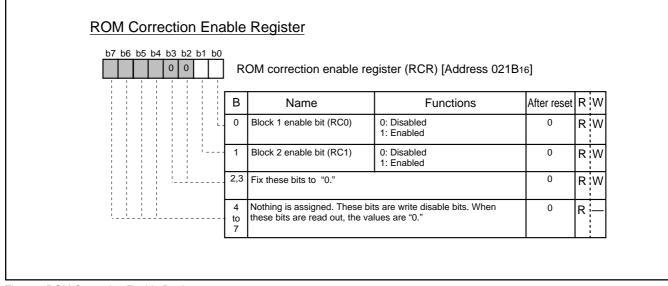


Fig. 52. ROM Correction Enable Register



MITSUBISHI MICROCOMPUTERS M37224M3-XXXSP

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RESET CIRCUIT

When the oscillation of a quartz-crystal oscillator or a ceramic resonator is stable and the power source voltage is 5 V ±10 %, hold the RESET pin at LOW for 2 μ s or more, then return it to HIGH. Then, as shown in Figure 53, reset is released and the program starts from the address formed by using the content of address FFFF16 as the high-order address and the content of the address FFFE16 as the

low-order address. The internal state of microcomputer at reset are shown in Figures 5 to 8.

An example of the reset circuit is shown in Figure 53.

The reset input voltage must be kept 0.6 V or less until the power source voltage surpasses 4.5 V.

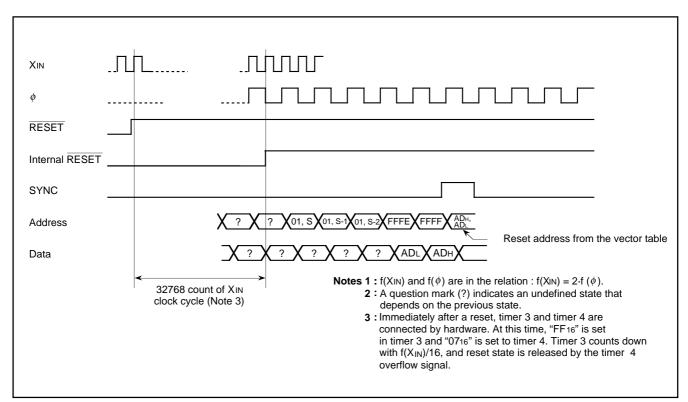


Fig. 53. Reset Sequence

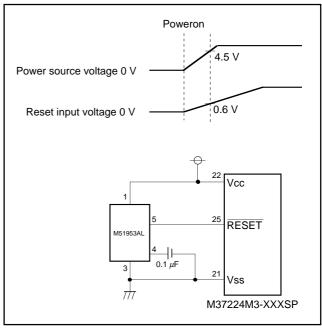


Fig. 54. Example of Reset Circuit



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

CLOCK GENERATING CIRCUIT

The built-in clock generating circuit is shown in Figure 57. When the STP instruction is executed, the internal clock ϕ stops at HIGH. At the same time, timers 3 and 4 are connected by hardware and "FF16" is set in timer 3 and "0716" is set in the timer 4. Select f(XIN)/16 as the timer 3 count source (set bit 0 of the timer 34 mode register to "0" before the execution of the STP instruction). Moreover, set the timer 3 and timer 4 interrupt enable bits to disabled ("0") before execution of the STP instruction). The oscillator restarts when external interrupt is accepted. However, the internal clock ϕ keeps its HIGH until timer 4 overflows, allowing time for oscillator is used.

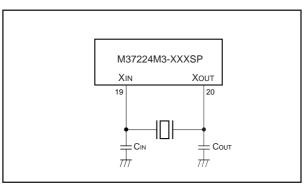
When the WIT instruction is executed, the internal clock ϕ stops in the HIGH but the oscillator continues running. This wait state is released when an interrupt is accepted (Note). Since the oscillator does not stop, the next instruction can be executed at once.

When returning from the stop or the wait state, to accept an interrupt, set the corresponding interrupt enable bit to "1" before executing the STP or the WIT instructions.

Note: In the wait mode, the following interrupts are invalid.

- (1) VSYNC interrupt
- (2) CRT interrupt
- (3) f(XIN)/4096 interrupt
- (4) Timer 1 interrupt using f(XIN)/4096 as count source
- (5) Timer 2 interrupt using P24/TIM2 pin input as count source
- (6) Timer 3 interrupt using P23/TIM3 pin input as count source
- (7) Timer 4 interrupt using f(XIN)/2 as count source
- (8) Multi-master I²C-BUS interface interrupt

A circuit example using a ceramic resonator (or a quartz-crystal oscillator) is shown in Figure 55. Use the circuit constants in accordance with the resonator manufacture's recommended values. A circuit example with external clock input is shown in Figure 56. Input the clock to the XIN pin, and open the XOUT pin.





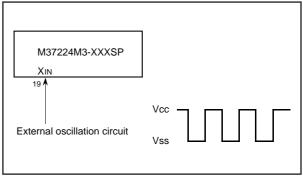


Fig. 56. External Clock Input Circuit Example

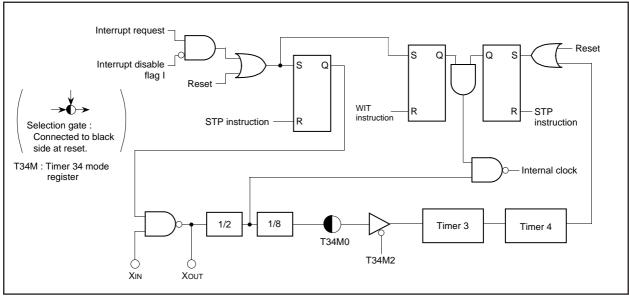


Fig. 57. Clock Generating Circuit Block Diagram



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DISPLAY OSCILLATION CIRCUIT

The CRT display clock oscillation circuit has a built-in clock oscillation circuits, so that a clock for CRT display can be obtained simply by connecting an LC, an RC, a ceramic resonator or a quartz-crystal oscillator circuit across the pins OSC 1 and OSC 2. Select the clock for display with bits 0 and 1 of the CRT clock selection register (address 00ED16).

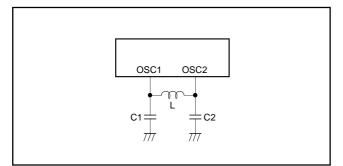


Fig. 58. Display Oscillation Circuit

AUTO-CLEAR CIRCUIT

When a power source is supplied, the auto-clear function will operate by connecting the following circuit to the $\overline{\text{RESET}}$ pin.

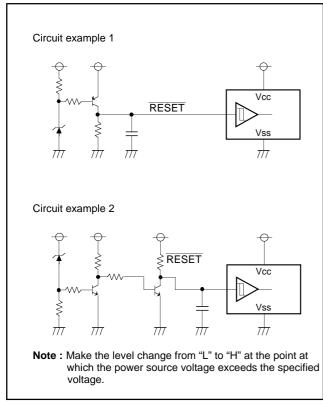


Fig. 59. Auto-clear Circuit Example

ADDRESSING MODE

The memory access is reinforced with 17 kinds of addressing modes. Refer to SERIES 740 <Software> User's Manual for details.

MACHINE INSTRUCTIONS

There are 71 machine instructions. Refer to SERIES 740 <Soft- ware> User's Manual for details.

PROGRAMMING NOTES

(1) The divide ratio of the timer is 1/(n+1).

- (2) Even though the BBC and BBS instructions are executed immediately after the interrupt request bits are modified (by the program), those instructions are only valid for the contents before the modification. At least one instruction cycle is needed (such as an NOP) between the modification of the interrupt request bits and the execution of the BBC and BBS instructions.
- (3) After the ADC and SBC instructions are executed (in the decimal mode), one instruction cycle (such as an NOP) is needed before the SEC, CLC, or CLD instruction is executed.
- (4) An NOP instruction is needed immediately after the execution of a PLP instruction.
- (5) In order to avoid noise and latch-up, connect a bypass capacitor ($\approx 0.1 \ \mu$ F) directly between the Vcc pin–Vss pin and the Vcc pin–CNVss pin, using a thick wire.

DATA REQUIRED FOR MASK ORDERS

The following are necessary when ordering a mask ROM production:

- (1) Mask ROM Order Confirmation From.
- (2) Mask Specification From.
- (3) Data to be written to ROM, in EPROM form (32-pin DIP Type 27C101, three identical copies).



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

ABSOLUTE MAXIMUM RATINGS

Symbol		Parameter	Conditions	Ratings	Unit
Vcc	Power source voltage	Vcc	All voltages are based	-0.3 to 6	V
VI	Input voltage	CNVss	on Vss. Output transistors are	–0.3 to 6	V
VI	Input voltage	P00–P07,P10–P17, P20–P27, P30–P34, OSC1, XIN, HSYNC, VSYNC, RESET	cut off.	-0.3 to Vcc + 0.3	V
Vo	Output voltage	P06, P07, P10–P17, P20–P27, P30–P32, R, G, B, OUT, D-A, Xout, OSC2		-0.3 to Vcc + 0.3	V
Vo	Output voltage	P00–P05	1	–0.3 to 13	V
Юн	Circuit current	R, G, B, OUT, P10–P17, P20–P27, P30, P31, D-A		0 to 1 (Note 1)	mA
IOL1	Circuit current	R, G, B, OUT, P06, P07, P10–P17, P20–P23, P30–P32, D-A		0 to 2 (Note 2)	mA
IOL2	Circuit current	P00-P05		0 to 1 (Note 2)	mA
IOL3	Circuit current	P24–P27		0 to 10 (Note 3)	mA
Pd	Power dissipation		Ta = 25 °C	550	mW
Topr	Operating temperature			-10 to 70	°C
Tstg	Storage temperature			-40 to 125	°C

RECOMMENDED OPERATING CONDITIONS (Ta = -10 °C to 70 °C, Vcc = 5 V ± 10 %, unless otherwise noted)

Currench al	Parameter			Limits				
Symbol				Min. Typ.		- Unit		
Vcc	Power source voltage (Note 4), Duri	Power source voltage (Note 4), During CPU, CRT operation			5.5	V		
Vss	Power source voltage		0	0	0	V		
VIH1	HIGH input voltage	P00–P07,P10–P17, P20–P2 <u>7, P30–</u> P34, SIN, SCLK, HSYNC, VSYNC, RESET, XIN, OSC1, TIM2, TIM3, INT1, INT2, INT3	0.8Vcc		Vcc	V		
VIL1	LOW input voltage	P00-P07,P10-P17, P20-P27, P30-P34	0		0.4 Vcc	V		
VIL2	LOW input voltage	HSYNC, VSYNC, RESET, TIM2, TIM3, INT1, INT2, INT3, XIN, OSC1, SIN, SCLK	0		0.2 Vcc	mA		
Юн	HIGH average output current (Note 1)	R, G, B, OUT, D-A, P10–P17, P20–P27, P30, P31			1	mA		
IOL1	LOW average output current (Note 2)	R, G, B, OUT, D-A, P06, P07, P10–P17, P20–P27, P30–P32			2	mA		
IOL2	LOW average output current (Note 2)	P00-P05			1	mA		
IOL3	LOW average output current (Note 3)	P24–P27			10	mA		
fCPU	Oscillation frequency (for CPU operation	ation) (Note 5) XIN	7.9	8.0	8.1	MHz		
fCRT	Oscillation frequency (for CRT displa	ay) (Note 5) OSC1	5.0		8.0	MHz		
fhs1	Input frequency	TIM2, TIM3			100	kHz		
fhs2	Input frequency	Sclk			1	MHz		

Notes 1: The total current that flows out of the IC must be 20 mA (max.).

2: The total input current to IC (IOL1 + IOL2) must be 30 mA or less.

3: The total average input current for ports P24–P27 to IC must be 20 mA or less.

4: Connect 0.1 μF or more capacitor externally between the power source pins Vcc–Vss so as to reduce power source noise. Also connect 0.1 μF or more capacitor externally between the pins Vcc–CNVss.

5: Use a quartz-crystal oscillator or a ceramic resonator for the CPU oscillation circuit.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

0	Parameter		Test conditions			11.2		
Symbol			Test cond	litions	Min. Typ.		Max.	Unit
Icc	Power source current	System operation	VCC = 5.5 V, f(XIN) = 8 MHz	CRTOFF		20	40	mA
				CRT ON		30	60	
		Stop mode	VCC = 5.5 V, f(X	(IN) = 0			300	μA
Vон	HIGH output voltage	R, G, B, OUT, D-A, P10–P17, P20–P27, P30, P31	Vcc = 4.5 V Іон = –0.5 mA	Vcc = 4.5 V				V
Vol	LOW output voltage	R, G, B, OUT, D-A, P00–P07, P10–P17, P20–P23, P30–P32	VCC = 4.5 V IOL = 0.5 mA				0.4	V
	LOW output voltage P24–P27		VCC = 4.5 V IOL = 10.0 mA				3.0	V
VT+VT-	Hysteresis	RESET	Vcc = 5.0 V			0.5	1.3	V
	Hysteresis (Note)	HSYNC, VSYNC, TIM2, TIM3, INT1, INT2, INT3, SIN, SCLK	Vcc = 5.0 V			0.5	1.3	
lizн	HIGH input leak current	RESET, P00–P07, P10–P17, P20–P27, P30–P34, HSYNC, VSYNC	Vcc = 5.5 V VI = 5.5 V				5	μA
lizl	LOW input leak current	RESET, P00–P07, P10–P17, P20–P27, P30–P34, HSYNC, VSYNC	VCC = 5.5 V VI = 0 V				5	μA
Іоzн	HIGH output leak curren	t P00–P05	Vcc = 5.5 V Vo = 12 V				10	μA

ELECTRIC CHARACTERISTICS (Vcc = 5 V ± 10 %, Vss = 0 V, f(XIN) = 8 MHz, Ta = -10 °C to 70 °C, unless otherwise noted)

Note: P06, P07, P15, P23, P24 have the hysteresis when these pins are used as interrupt input pins or timer input pins. P20–P22 have the hysteresis when these pins are used as serial I/O pins.



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

A-D COMPARATOR CHARACTERISTICS

(VCC = 5 V ± 10 %, VSS = 0 V, f(XIN) = 8 MHz, Ta = -10 °C to 70 °C, unless otherwise noted)

Cumbal	Description	Test conditions		Linit		
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
—	Resolution				6	bits
_	Absolute accuracy		0	±1	±2	LSB

Note: When Vcc = 5 V, 1 LSB = 5/64 V.

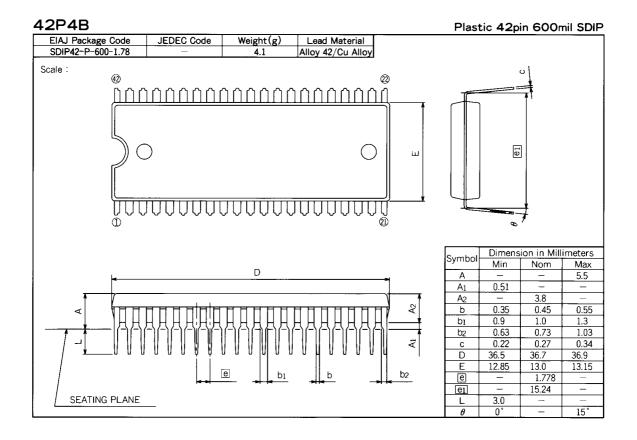
D-A CONVERTER CHARACTERISTICS (Vcc = 5 V \pm 10 %, Vss = 0 V, f(XIN) = 8 MHz, Ta = -10 °C to 70 °C, unless otherwise noted)

Symbol	Deventer	Test senditions		Unit			
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
—	Resolution				7	bits	
_	Absolute accuracy				2	%	
tsu	Setting time				3	μs	
Ro	Output resistor		1	2.5	4	kΩ	



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

PACKAGE OUTLINE





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

GZZ-SH11-11B < 6XA0 >

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37224M3-XXXSP **MITSUBISHI ELECTRIC**

	Date :	
t	Section head signature	Supervisor signature
Receipt		
Re		

Mask ROM number

Note : Please fill in all items marked *.

		Company		TEL			Submitted by	Supervisor
*	Customer	name		()	ance ature		
1		Date issued	Date :			lssu sign		

* 1. Confirmation

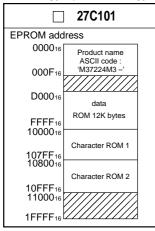
Specify the name of the product being ordered and the type of EPROMs submitted.

Three EPROMs are required for each pattern.

If at least two of the three sets of EPROMs submitted contain identical data, we will produce masks based on this data. We shall assume the responsibility for errors only if the mask ROM data on the products we produce differs from this data. Thus, extreme care must be taken to verify the data in the submitted EPROMs.

Checksum code for entire EPROM					(hexadecimal notation)
--------------------------------	--	--	--	--	------------------------

EPROM type (indicate the type used)



Set "FF16" in the shaded area. (1)

Write the ASCII codes that indicate the product name of "M37220M3-" to addresses 0000 16 to 000F16. (2)

EPROM data check item (confirm the EPROM data and check " </ " the appropriate box)

● Is "FF16" in the shaded area ?

- \rightarrow Yes \square
- Are the ASCII codes that indicates the product
- \rightarrow Yes \square name of "M37224M3-" to addresses 0000 16 to 000F16?

2. Mark specification

Mark specification must be submitted using the correct form for the type of package being ordered. Fill out the appropriate mark specification form (42P4B for M37224M3-XXXSP) and attach to the mask ROM confirmation form.

* 3. Comments

(1/3)



GZZ-SH11-22B <6XA0 >

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37224M3-XXXSP MITSUBISHI ELECTRIC

How to Write the Product Name and Character ROM Data onto EPROMs

Addresses 0000₁₆ to 000F₁₆ store the product name, and addresses 10000₁₆ to 10FFF₁₆ store the character pattern. If the name of the product contained in the EPROMs does not match the name on the mask ROM confirmation form, the ROM processing is disabled. Please make sure the data is written correctly.

 How to input the name of the product with the ASCII code ASCII codes 'M37224M3-' are listed on the right. The addresses and data are in hexadecimal notation.

Address		Address	
000016	'M' = 4 D ₁₆	000816	'–' = 2 D ₁₆
000116	'3' = 3 3 ₁₆	000916	F F ₁₆
000216	'7' = 3 7 ₁₆	000A16	F F ₁₆
000316	'2' = 3 2 ₁₆	000B16	F F ₁₆
000416	'2' = 3 2 ₁₆	000C16	F F ₁₆
000516	'4' = 3 4 ₁₆	000D16	F F ₁₆
000616	'M' = 4 D ₁₆	000E16	F F ₁₆
000716	'3' = 3 3 ₁₆	000F16	F F ₁₆

 Inputting the character ROM Input the character ROM data by dividing it into character ROM1 and character ROM2. For the character ROM data, see the next page and on.

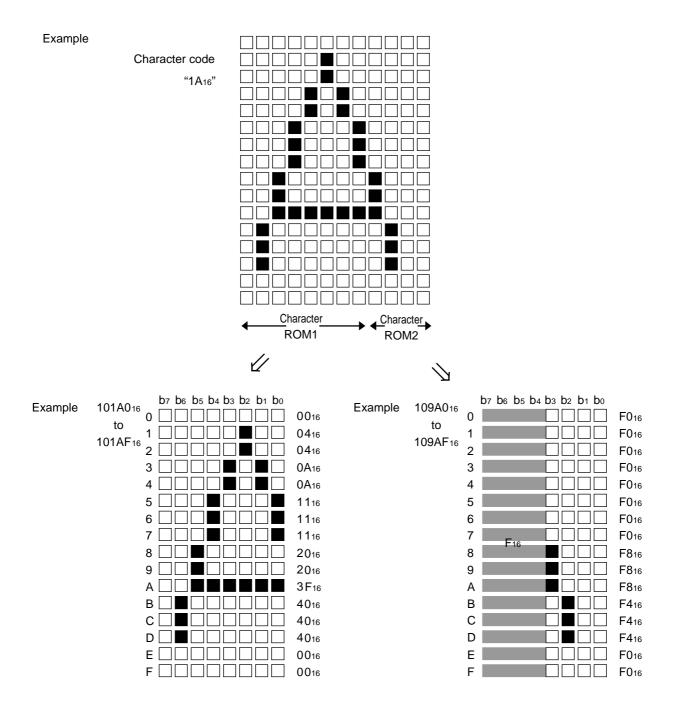




GZZ-SH11-22B< 6XA0 >

740 FAMILY MASK ROM CONFIRMATION FORM SINGLE-CHIP MICROCOMPUTER M37224M3-XXXSP MITSUBISHI ELECTRIC

The structure of character ROM (divided of 12 ×16 dots font)



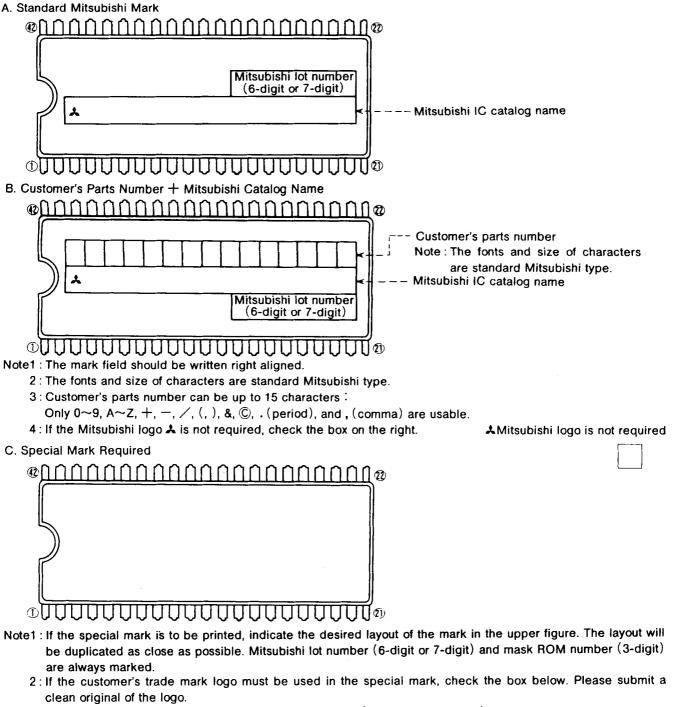


MITSUBISHI MICROCOMPUTERS M37224M3-XXXSP

42P4B (42-PIN SHRINK DIP) MARK SPECIFICATION FORM

Mitsubishi IC catalog name

Please choose one of the marking types below (A, B, C), and enter the Mitsubishi IC catalog name and the special mark (if needed).



For the new special character fonts a clean font original (ideally logo drawing) must be submitted.

The standard Mitsubishi font is used for all characters except for a logo.

Special logo required

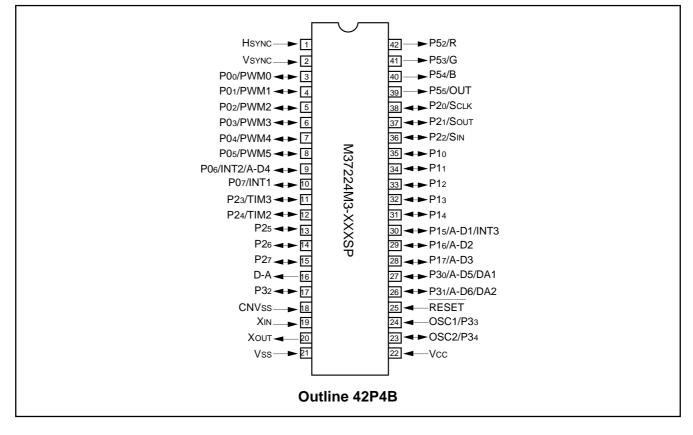
i



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

APPENDIX

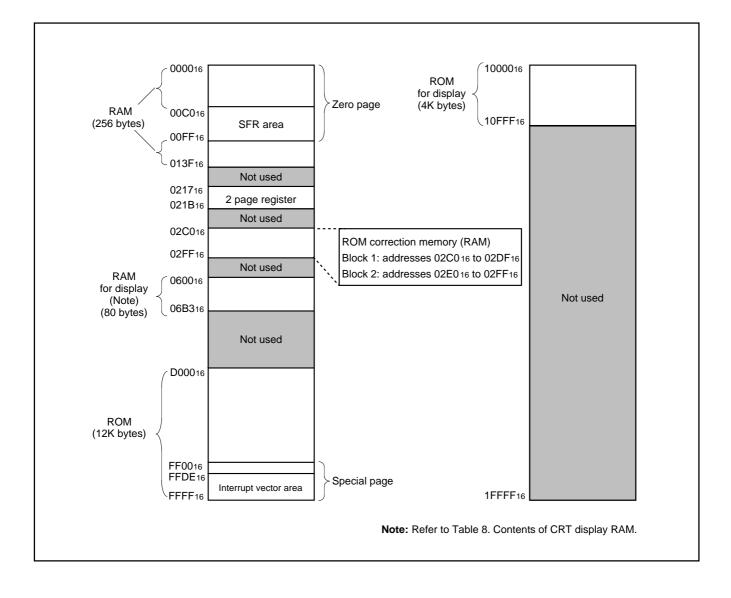
Pin Configuration (TOP VIEW)





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Memory Map





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Memory Map of Special Function Register (SFR)

■SFR Area (addresses C016 t	to DF16)	
·	<bit allocation=""></bit>	<state after="" immediately="" reset=""></state>
	$\Box \cdot ,$	0 : "0" immediately after reset
	Function bit	
	Name . 2	1 : "1" immediately after reset
	: No function bit	? : Undefined immediately after reset
	0 : Fix this bit to "0" (do not write "1")	aner reset
	1 : Fix this bit to "1"	
	(do not write "0")	
Address Register	Bit allocation	State immediately after reset
C0 ₁₆ Port P0 (P0)		?
C1 ₁₆ Port P0 direction register (D0)		0016
C2 ₁₆ Port P1 (P1)		?
C3 ₁₆ Port P1 direction register (D1)		0016
C4 ₁₆ Port P2 (P2)		?
C5 ₁₆ Port P2 direction register (D2)		0016
C616 Port P3 (P3)		0 0 0 ? ? ? ? ?
C7 ₁₆ Port P3 direction register (D3)		0016
C8 16		?
C916		?
CA ₁₆ Port P5 (P5)		0 0 ? ? ? ? ? ?
CB ₁₆ Port P5 direction register (D5)		0016
CC16		?
CD ₁₆ Port P3 output mode control register (P3S)	DA2S DA1S P31S P30S	0016
CE ₁₆ DA-H register (DA-H)		?
CF ₁₆ DA-L register (DA-L)		0 0 ? ? ? ? ? ?
D0 ₁₆ PWM0 register (PWM0)		?
D1 ₁₆ PWM1 register (PWM1)		?
D2 ₁₆ PWM2 register (PWM2)		?
D316 PWM3 register (PWM3)		?
D4 ₁₆ PWM4 register (PWM4)		?
D5 ₁₆ PWM output control register 1 (PW)	PW7 PW6 PW5 PW4 PW3 PW2 PW1 PW0	0016
D6 ₁₆ PWM output control register 2 (PN)	PN4 PN3 PN2	0016
D716		?
D816		?
D916		?
DA16		?
DB ₁₆ DC ₁₆ Serial I/O mode register (SM)		?
DD ₁₆ Serial I/O register (SIO)	SM6 SM5 0 SM3 SM2 SM1 SM0	0016
DE16 DA1 conversion register (DA1)		?
DF ₁₆ DA2 conversion register (DA2)	DA17 0 DA15 DA14 DA13 DA12 DA11 DA10	
	DA27 0 DA25 DA24 DA23 DA22 DA21 DA20	



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

	<bit allocation=""></bit>	<state after="" immediately="" reset=""></state>
	Function bit	0 : "0" immediately after reset
	Name : J	1 : "1" immediately after reset
	: No function bit	? : Undefined immediately
	0 : Fix this bit to "0"	after reset
	(do not write "1")	
	1 : Fix this bit to "1" (do not write "0")	
Address Register	Bit allocation	State immediately after reset
	b7 b HR5 HR4 HR3 HR2 HR1 HR	0 b7 b0 0 0016
E0 ₁₆ Horizontal register (HR) E1 ₁₆ Vertical register 1 (CV1)	CV16 CV15 CV14 CV13 CV12 CV11 CV1	
E2 ₁₆ Vertical register 1 (CV1)	CV26 CV25 CV24 CV23 CV22 CV21 CV2	
E316		?
E4 ₁₆ Character size register (CS)	CS21 CS20 CS11 CS1	0 0 0 0 ? ? ? ?
E5 ₁₆ Border selection register (MD)	MD20 MD1	0 0 0 0 0 0 ? 0 ?
E616 Color register 0 (CO0)	CO05 CO03 CO02 CO01 0	0016
E7 ₁₆ Color register 1 (CO1)	C015 C013 C012 C011 0	0016
E816 Color register 2 (CO2)	CO25 CO23 CO22 CO21 0	0016
E9 ₁₆ Color register 3 (CO3)	CO35 CO33 CO32 CO31 0	0016
EA ₁₆ CRT control register (CO)		0 0016
EB16		?
EC16 CRT port control register (CRTP)	OP7 OP6 OP5 OUT R/G/B VSYC HSY	C 0016
ED ₁₆ CRT clock selection register (CK)	0 0 0 0 0 0 ск1 ск	
EE ₁₆ A-D control register 1 (AD1)	ADM4 ADM2ADM1ADM	
EF ₁₆ A-D control register 2 (AD2)	ADC5ADC4ADC3ADC2ADC1ADC	0010
F0 ₁₆ Timer 1 (TM1)		FF16
F1 ₁₆ Timer 2 (TM2)		0716
F2 ₁₆ Timer 3 (TM3)		FF16 0716
F3 ₁₆ Timer 4 (TM4)	0 T12M4 T12M3 T12M2 T12M1 T12N	
F4 ₁₆ Timer 12 mode register (T12M) F5 ₁₆ Timer 34 mode register (T34M)	T34M5 T34M4 T34M3 T34M2 T34M1 T34M	0010
F516 FIME 34 mode register (134M) F616 PWM5 register (PWM5)		?
F016 F 10101 Tegister (F 10103)		?
F 7 16 F 8 16		?
F9 ₁₆ Interrupt input polarity register (RE)	0 RE5 RE4 RE3 0 0	
FA_{16} Test register (TEST)	0016	0016
FB ₁₆ CPU mode register (CPUM)	1 1 1 1 1 CM2 0 0	
FC ₁₆ Interrupt request register 1 (IREQ1)	IT3R VSCRCRTRTM4RTM3RTM2RTM1	
FD ₁₆ Interrupt request register 2 (IREQ2)	0 MSR S1R IT2R IT11	
	IT3E VSCECRTETM4E TM3E TM2E TM1	
FE ₁₆ Interrupt control register 1 (ICON1)		E 0016



MITSUBISHI MICROCOMPUTERS

M37224M3-XXXSP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

■SFR Area (addresses 217₁	16 to 21B 16)	
	<bit allocation=""> Sume Function bit Nume No function bit Fix this bit to "0" (do not write "1") Fix this bit to "1" (do not write "0")</bit>	<state after="" immediately="" reset=""> 0 : "0" immediately after reset 1 : "1" immediately after reset ? : Undefined immediately after reset</state>
AddressRegister21716ROM correction address 1 (high-order)21816ROM correction address 1 (low-order)21916ROM correction address 2 (high-order)21A16ROM correction address 2 (low-order)21B16ROM correction enable register (RCR)	Bit allocation bo	State immediately after reset b0 $b7$ 0016 0016 0016 0016 0016 0016 0016 0216 0016 0216 0016



MITSUBISHI MICROCOMPUTERS M37224M3-XXXSP

SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

Internal State of Processor Status Register and Program Counter at Reset

	<bit allocation=""></bit>	<state after="" immediately="" reset=""></state>
		0 : "0" immediately after reset
	Name : Function bit	1 : "1" immediately after reset
	: No function bit	? : Undefined immediately
	0 : Fix this bit to "0" (do not write "1")	after reset
	1 : Fix this bit to "1" (do not write "0")	
Register	Bit allocation	State immediately after reset
Processor status register (PS)	N V T B D I Z (C ? ? ? ? ? 1 ? ?
Program counter (PCH)		Contents of address FFFF16
Program counter (PCL)		Contents of address FFFE ₁₆



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

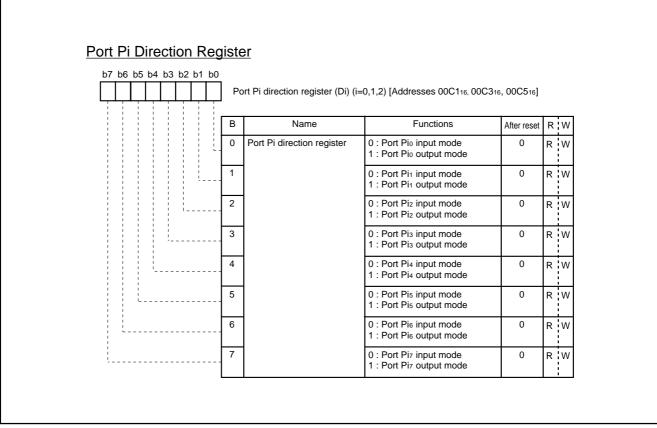
Structure of Register

The figure of each register structure describes its functions, contents at reset, and attributes as follows:

<u>CPU Mode Register</u> <u>b7b6 b5 b4b3 b2 b1 b0</u> <u>1 1 1 0 0</u> B 0, 1	/	Bit ediately after reset relevant M) (CM) [Address FB 16] Functions b1 b0 0 0: Single-chip mode 0 1: 1 0: 1 0: 1 1: Not available	After reset	te 1)	2)
2	Stack page selection bit (Note) (CM2)	0: 0 page 1: 1 page	0	RW	
3, 4	Fix these bits to "1."	•	1	RW	
5	Nothing is assigned. The When this bit is read o	his bit is write disable bit. ut, the value is "0."	1	RW	
6, 7	Clock switch bits (CM6, CM7)	b7 b6 0 0: f(XIN) = 8 MHz 0 1: f(XIN) = 12 MHz 1 0: f(XIN) = 16 MHz 1 1: Do not set	0	RW	
	: Bit in which nothing is	assigned			
1••••••"1" after ?••••••Indete 2: Bit attributes•••••	er reset release er reset release rminate after reset relea •The attributes of contro	ol register bits are classifie			
a R•••••Read	and read and write. In the	e figure, these attributes a W••••••Write	re repres	ented as	s follows :
○ ••••	•••Read enabled •••Read disabled	•	disabled	by soft	ware, but "1"

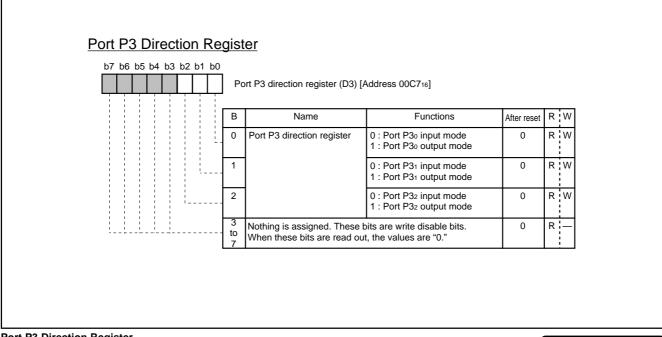


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER



Port Pi Direction Register

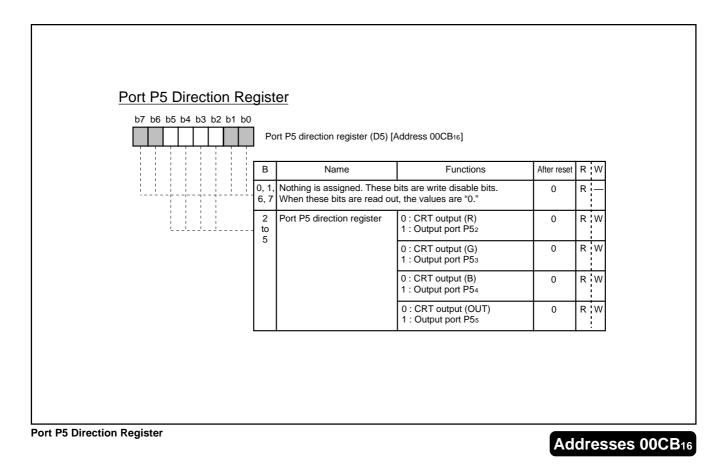
Addresses 00C116, 00C316, 00C516



Port P3 Direction Register



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER



b7 b6 b5 b4	b3 b2 b1 b0	Pc	ort P3 output mode control r	egister (P3S) [address 00CD16]		
		В	Name	Functions	After reset	RW
		0	P30 output structure selection bit (P30S)	0 : CMOS output 1 : N-channel open-drain output	0	RW
	· · · · · · · · · · · · · · · · · · ·	1	P31 output structure selection bit (P31S)	0 : CMOS output 1 : N-channel open-drain output	0	RW
	· · · · · · · · · · · · · · · · · · ·	2	DA1 output enable bit	0 : P3₀ input/output 1 : DA1 output	0	RW
	- 	3	DA2 output enable bit	0 : P31 input/output 1 : DA2 output	0	RW
		4 to 7	Nothing is assigned. These When these bits are read of	e bits are write disable bits. but, the values are "0."	0	R —

Port P3 Output Mode Control Register

Address 00CD16



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

b7 b6 b5 b4 b3 b2 b1 b0						
	P١	WM output control registe	er 1 (PW) [Address 00D516]			
	В	Name	Functions	After reset	R	W
	0	DA, PWM count source selection bit (PW0)	0 : Count source supply 1 : Count source stop	0	R	W
· · · · · · · · · · · · · · · · · · ·	1	DA/PN4 output selection bit (PW1)	0 : DA output 1 : PN4 output	0	R	W
	2	P00/PWM0 output selection bit (PW2)	0: P0o output 1: PWM0 output	0	R	W
	3	P01/PWM1 output selection bit (PW3)	0: P01 output 1: PWM1 output	0	R	W
· · · · · · · · · · · · · · · · · · ·	4	P02/PWM2 output selection bit (PW4)	0: P02 output 1: PWM2 output	0	R	W
	5	P03/PWM3 output selection bit (PW5)	0: P03 output 1: PWM3 output	0	R	W
	6	P04/PWM4 output selection bit (PW6)	0: P04 output 1: PWM4 output	0	R	W
l	7	P05/PWM5 output selection bit (PW7)	0: P05 output 1: PWM5 output	0	R	W

PWM Output Control Register 1

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Address 00D516

b7 b6 b5 l	b4b3b2b1b0	P\	WM output control registe	er 2 (PN) [Address 00D616]			
		В	Name	Functions	After reset	R	W
		0, 1		ese bits are write disable bits. d out, the values are "0."	0	R	-
		2	DA output polarity selection bit (PN3)	0 : Positive polarity 1 : Negative polarity	0	R	W
		3	PWM output polarity selection bit (PN4)	0 : Positive polarity 1 : Negative polarity	0	R	W
		4	DA general-purpose output bit (PN5)	0 : Output LOW 1 : Output HIGH	0	R	W
		5 to 7		ese bits are write disable bits. d out, the values are "0."	0	R	_

PWM Output Control Register 2

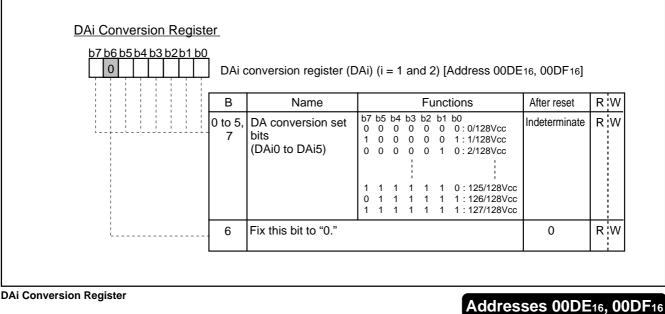


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

b7b6b5b4b3	b2b1b0	_				
		s	erial I/O mode register (SM) [Address 00DC16]		
		В	Name	Functions	After reset	RW
		0, 1	Internal synchronous clock selection bits (SM0, SM1)	b1 b0 0 0: f(XIN)/4 0 1: f(XIN)/16 1 0: f(XIN)/32 1 1: f(XIN)/64	0	RW
	, , , , ,	2	Synchronous clock selection bit (SM2)	0: External clock 1: Internal clock	0	RW
-		3	Serial I/O port selection bit (SM3)	0: P20, P21 functions as port 1: ScLK, SOUT	0	RW
		4	Fix this bit to "0."		0	RW
		5	Transfer direction selection bit (SM5)	0: LSB first 1: MSB first	0	RW
		6	Serial input pin selection bit (SM6)	0: Input signal from SIN pin 1: Input signal from SOUT pin	0	RW
		7	Nothing is assigned. T When this bit is read o	his bit is a write disable bit. ut, the value is "0."	0	R –

Serial I/O Mode Register

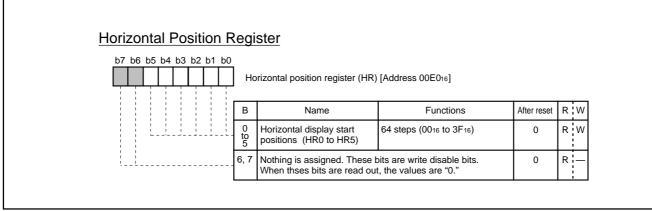
Address 00DC16



DAi Conversion Register

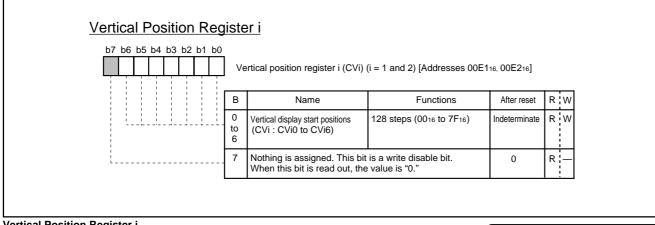


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER



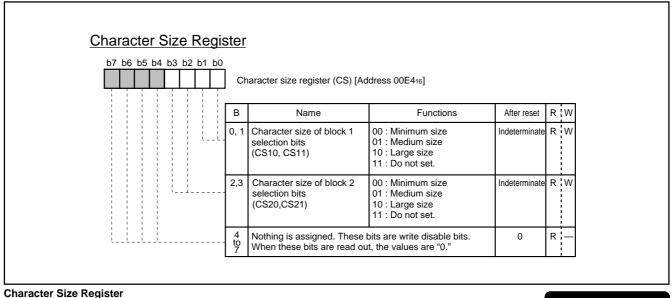
Horizontal Position Register

Address 00E016



Vertical Position Register i

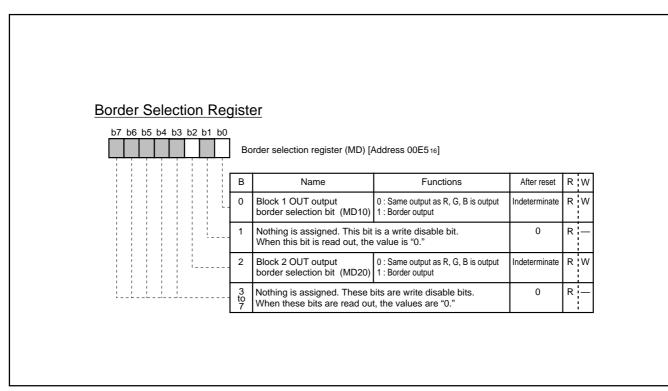
Address 00E116, 00E216



Address 00E416

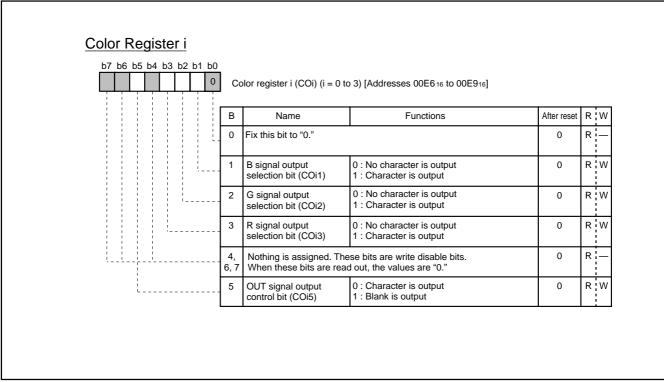


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER



Border Selection Register

Address 00E516

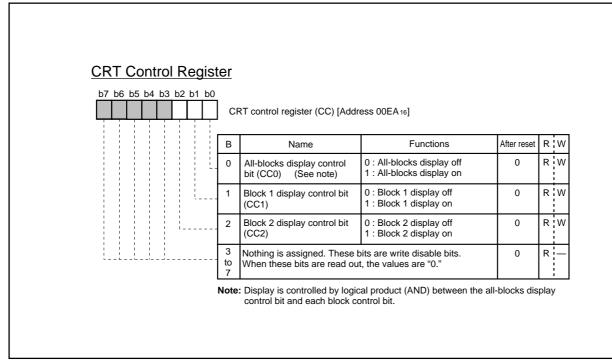


Color Register i

Addresses 00E616 to 00E916



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER



CRT Control Register

CRT Port Control Register b7 b6 b5 b4 b3 b2 b1 b0 CRT port control register (CRTP) [Address 00EC16] After reset RW в Name Functions RW 0 HSYNC input polarity 0 : Positive polarity 0 switch bit (HSYC) 1 : Negative polarity 1 VSYNC input polarity 0 : Positive polarity 0 RW switch bit (VSYC) 1 : Negative polarity 2 R/G/B output polarity switch 0 : Positive polarity 0 RW bit (R/G/B) 1 : Negative polarity 3 Nothing is assigned. This bit is a write disable bit. 0 R When this bit is read out, the value is "0." 4 OUT output polarity 0 R¦W 0 : Positive polarity switch bit (OUT) 1 : Negative polarity 0 RİW 5 R signal output switch bit 0 : R signal output (OP5) 1 : MUTE signal output 6 G signal output switch bit 0 : G signal output 0 RW (OP6) 1 : MUTE signal output 7 B signal output switch bit 0 : B signal output 0 R¦W (OP7) 1 : MUTE signal output

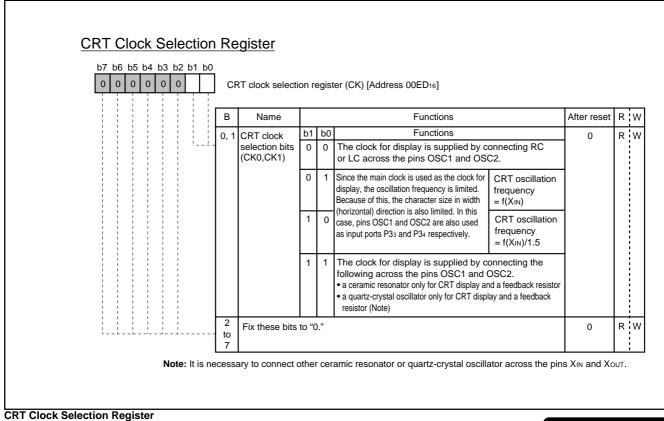
CRT Port Control Register

Address 00EC16

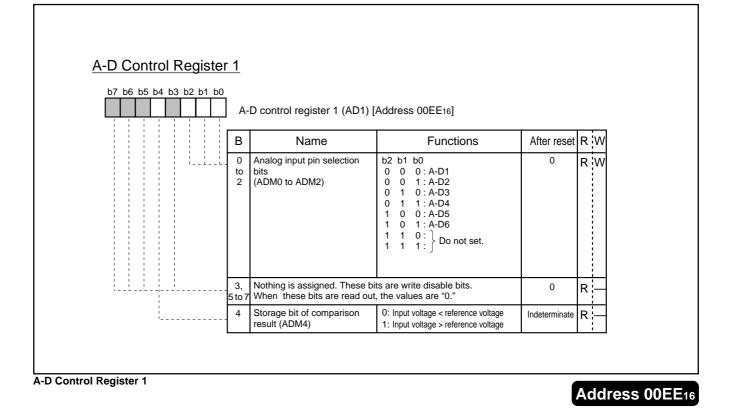
Address 00EA16



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

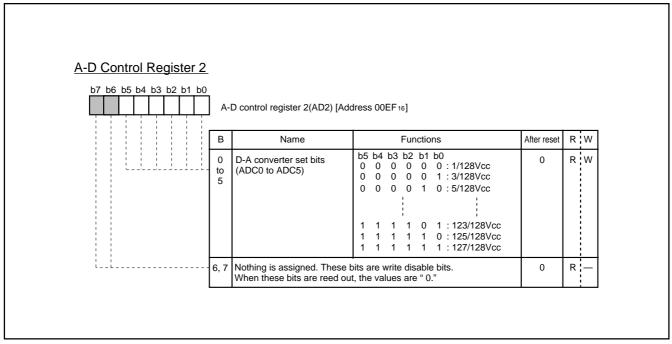


Address 00ED16





SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER



A-D Control Register 2

Timer 12 Mode Register b7b6b5b4b3b2b1b0 0 Timer 12 mode register (T12M) [Address 00F416] В After reset RW Name Functions 0: f(XIN)/16 0 Timer 1 count source RW 0 1: f(XIN)/4096 selection bit (T12M0) 0: Internal clock 0 RİW 1 Timer 2 count source 1: External clock from selection bit TIM2 pin (T12M1) 2 Timer 1 count 0: Count start 0 R W stop bit (T12M2) 1: Count stop Timer 2 count stop 3 0: Count start 0 RİW bit (T12M3) 1: Count stop 4 0: f(XIN)/16 0 R W Timer 2 internal count 1: Timer 1 overflow source selection bit (T12M4) 5 Fix this bit to "0." R¦W 0 6,7 Nothing is assigned. These bits are write disable 0 R bits. When these bits are read out, the values are "0."

Timer 12 Mode Register

Address 00F416

Address 00EF16



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER

b7b6b5b4b3b2b1b0	Ti	mer 34 mode register (T	34M) [Address 00F516]			
	В	Name	Functions	After reset	R	W
	0	Timer 3 count source selection bit (T34M0)	0: f(XIN)/16 1: External clock	0	R	W
	1	Timer 4 internal count source selection bit (T34M1)	0: Timer 3 overflow 1: f(XIN)/16	0	R	W
· · · · · · · · · · · · · · · · · · ·	2	Timer 3 count stop bit (T34M2)	0: Count start 1: Count stop	0	R	W
	3	Timer 4 count stop bit (T34M3)	0: Count start 1: Count stop	0	R	W
	4	Timer 4 count source selection bit (T34M4)	0: Internal clock 1: f(XIN)/2	0	R	w
	5	Timer 3 external count source selection bit (T34M5)	0: External clock from TIM3 pin 1: External clock from Hsync pin	0	R	w
	6,7		ese bits are write disable e read out, the values are	0	R	_

Timer 34 Mode Register

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Address 00F516

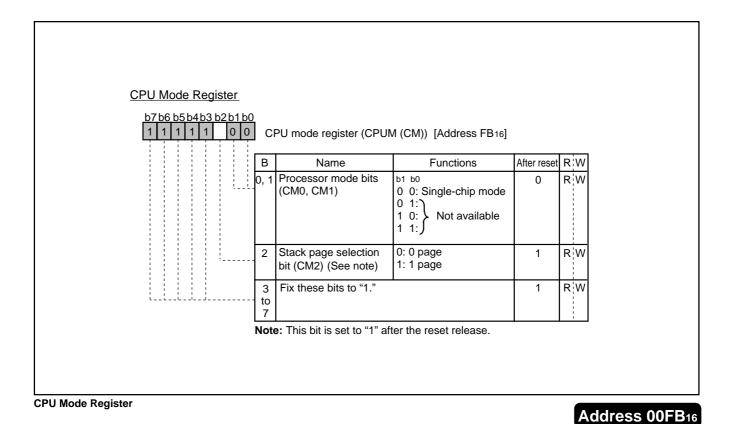
b7 b6 b5	5 b4 b3 b2 b1 b0 0 0	Int	errupt input polarity register	(RE) [Address 00F9 ₁₆]			
		В	Name	Functions	After reset	R	W
		0	Nothing is assigned. This b When this bit is read out, th		Indeterminate	R	
		1, 2	Fix these bits to "0."		0	R	W
	· · · · · · · · · · · · · · · · · · ·	3	INT1 polarity switch bit (RE3)	0 : Positive polarity 1 : Negative polarity	0	R	W
	 	4	INT2 polarity switch bit (RE4)	0 : Positive polarity 1 : Negative polarity	0	R	W
		5	INT3 polarity switch bit (RE5)	0 : Positive polarity 1 : Negative polarity	0	R	W
		6	Nothing is assigned. This b When this bit is read out, th		0	R	-
		7	Fix this bit to "0."		0		W

Interrupt Input Polarity Register

Address 00F916



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER



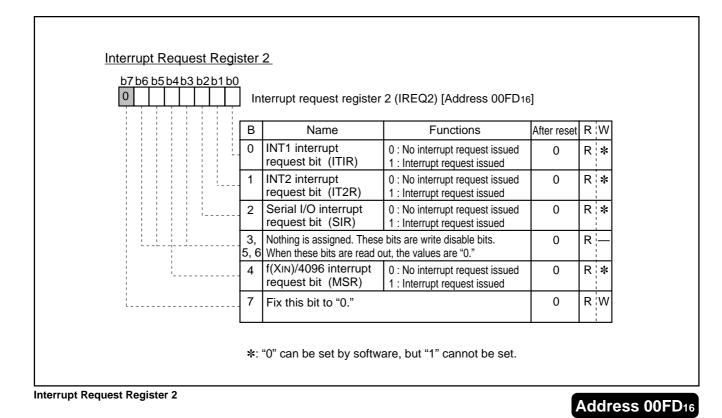
Interrupt Request Register 1 b7b6b5b4b3b2b1b0 Interrupt request register 1 (IREQ1) [Address 00FC16] RİW в Name Functions After reset 0 0 R * Timer 1 interrupt 0 : No interrupt request issued 1 : Interrupt request issued request bit (TM1R) 0 R ¦ * 1 Timer 2 interrupt 0 : No interrupt request issued request bit 1 : Interrupt request issued (TM2R) 0 R : * 2 Timer 3 interrupt 0 : No interrupt request issued 1 : Interrupt request issued request bit (TM3R) 0 3 Timer 4 interrupt 0 : No interrupt request issued R 🛪 request bit (TM4R) 1 : Interrupt request issued 4 CRT interrupt 0 R ¦* 0 : No interrupt request issued request bit (CRTR) 1 : Interrupt request issued 0 5 VSYNC interrupt 0 : No interrupt request issued R ¦* (VSCR) request bit 1 : Interrupt request issued Nothing is assigned. This bit is a write disable bit. 6 0 R When this bit is read out, the value is "0." R 🕯 0 7 INT3 interrupt 0: No interrupt request issued request bit (IT3R) 1 : Interrupt request issued

Interrupt Request Register 1

Address 00FC16



SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER



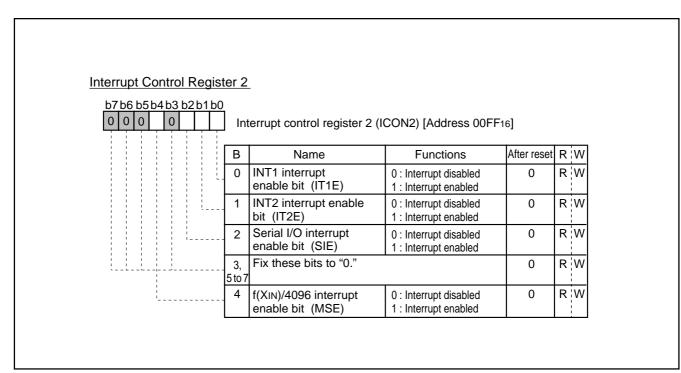
Interrupt Control Regis	ter 1					
b7b6b5b4b3b2b1b0	1	terrupt control register 1 (I	CON1) [Address 00FE	16]		
	В	Name	Functions	After reset	R	W
	0	Timer 1 interrupt enable bit (TM1E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	1	Timer 2 interrupt enable bit (TM2E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	2	Timer 3 interrupt enable bit (TM3E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	3	Timer 4 interrupt enable bit (TM4E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	4	CRT interrupt enable bit (CRTE)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	5	Vsync interrupt enable bit (VSCE)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W
	6	Nothing is assigned. This bit. When this bit is read		0	R	_
	7	INT3 interrupt enable bit (IN3E)	0 : Interrupt disabled 1 : Interrupt enabled	0	R	W

Interrupt Control Register 1

Address 00FE16

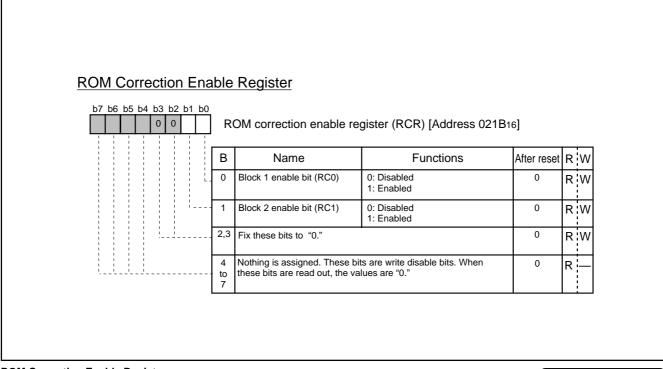


SINGLE-CHIP 8-BIT CMOS MICROCOMPUTER for VOLTAGE SYNTHESIZER with ON-SCREEN DISPLAY CONTROLLER



Interrupt Control Register 2

Address 00FF16



ROM Correction Enable Register

Address 021B16



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